### Features

- 80C52 Compatible
  - 8051 Pin and Instruction Compatible
  - Four 8-bit I/O Ports
  - Three 16-bit Timer/Counters
  - 256 Bytes Scratch Pad RAM
  - 9 Interrupt Sources with 4 Priority Levels
  - Dual Data Pointer
- Variable Length MOVX for Slow RAM/Peripherals
- ISP (In-system Programming) Using Standard V<sub>CC</sub> Power Supply
- Boot ROM Contains Low Level Flash Programming Routines and a Default Serial Loader
- High-speed Architecture
  - In Standard Mode:
    - 40 MHz (Vcc 2.7V to 5.5V, both Internal and external code execution) 60 MHz (Vcc 4.5V to 5.5V and Internal Code execution only)
    - In X2 mode (6 Clocks/machine cycle)
       20 MHz (Vcc 2.7V to 5.5V, both Internal and external code execution)
       30 MHz (Vcc 4.5V to 5.5V and Internal Code execution only)
    - 16K/32K Bytes On-chip Flash Program/Data Memory
  - Byte and Page (128 Bytes) Erase and Write
  - 100K Write Cycles
- On-chip 1024 Bytes Expanded RAM (XRAM)
  - Software Selectable Size (0, 256, 512, 768, 1024 Bytes)
  - 256 Bytes Selected at Reset for TS87C51RB2/RC2 Compatibility
- Keyboard Interrupt Interface on Port P1
- SPI Interface (Master/Slave Mode)
- 8-bit Clock Prescaler
- Improved X2 Mode with Independent Selection for CPU and Each Peripheral
- Programmable Counter Array 5 Channels
  - High-speed Output
  - Compare/Capture
  - Pulse Width Modulator
  - Watchdog Timer Capabilities
- Asynchronous Port Reset
- Full Duplex Enhanced UART
- Dedicated Baud Rate Generator for UART
- Low EMI (Inhibit ALE)
- Hardware Watchdog Timer (One-time Enabled with Reset-out)
- Power Control Modes
   Idle Mode
  - Idle Mode
     Power-down Mode
  - Power-down Mode
- Power-off Flag
- Power Supply:
  - 2.7 to 3.6 (3V Version)
  - 2.7 to 5.5V (5V Version)
- Temperature Ranges: Commercial (0 to +70°C) and Industrial (-40°C to +85°C)
- Packages: PDIL40, PLCC44, VQFP44

### Description

The AT89C51RB2/RC2 is a high-performance Flash version of the 80C51 8-bit microcontrollers. It contains a 16K or 32K Bytes Flash memory block for program and data.

The Flash memory can be programmed either in parallel mode or in serial mode with the ISP capability or with software. The programming voltage is internally generated from the standard VCC pin.





8-bit Microcontroller with 16K/ 32K Bytes Flash

## AT89C51RB2 AT89C51RC2



The AT89C51RB2/RC2 retains all features of the 80C52 with 256 Bytes of internal RAM, a 9-source 4-level interrupt controller and three timer/counters.

In addition, the AT89C51RB2/RC2 has a Programmable Counter Array, an XRAM of 1024 Bytes, a Hardware Watchdog Timer, a Keyboard Interface, an SPI Interface, a more versatile serial channel that facilitates multiprocessor communication (EUART) and a speed improvement mechanism (X2 mode).

The Pinout is the standard 40/44 pins of the C52.

The fully static design reduces system power consumption of the AT89C51RB2/RC2 by allowing it to bring the clock frequency down to any value, even DC, without loss of data.

The AT89C51RB2/RC2 has 2 software-selectable modes of reduced activity and 8-bit clock prescaler for further reduction in power consumption. In Idle mode, the CPU is frozen while the peripherals and the interrupt system are still operating. In power-down mode, the RAM is saved and all other functions are inoperative.

The added features of the AT89C51RB2/RC2 make it more powerful for applications that need pulse width modulation, high speed I/O and counting capabilities such as alarms, motor control, corded phones, and smart card readers.

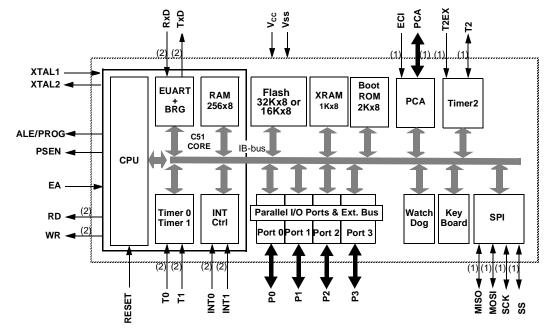
Part Number	Flash (Bytes)	XRAM (Bytes)	TOTAL RAM (Bytes)	I/O
AT89C51RB2	16K	1024	1280	32
AT89C51RC2	32K	1024	1280	32
AT89C51IC2	32K	1024	1280	32

Table 1. Memory Size

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### **Block Diagram**

Figure 1. Block Diagram



- Notes: 1. Alternate function of Port 1.
  - 2. Alternate function of Port 3.





### **SFR Mapping**

The Special Function Registers (SFRs) of the AT89C51RB2/RC2 fall into the following categories:

- C51 core registers: ACC, B, DPH, DPL, PSW, SP
- I/O port registers: P0, P1, P2, P3
- Timer registers: T2CON, T2MOD, TCON, TH0, TH1, TH2, TMOD, TL0, TL1, TL2, RCAP2L, RCAP2H
- Serial I/O port registers: SADDR, SADEN, SBUF, SCON
- PCA (Programmable Counter Array) registers: CCON, CCAPMx, CL, CH, CCAPxH, CCAPxL (x: 0 to 4)
- Power and clock control registers: PCON
- Hardware Watchdog Timer registers: WDTRST, WDTPRG
- Interrupt system registers: IEN0, IPL0, IPH0, IEN1, IPL1, IPH1
- Keyboard Interface registers: KBE, KBF, KBLS
- SPI registers: SPCON, SPSTR, SPDAT
- BRG (Baud Rate Generator) registers: BRL, BDRCON
- Flash register: FCON
- Clock Prescaler register: CKRL
- Others: AUXR, AUXR1, CKCON0, CKCON1

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#### Table 2. C51 Core SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
ACC	E0h	Accumulator								
В	F0h	B Register								
PSW	D0h	Program Status Word	CY	AC	F0	RS1	RS0	OV	F1	Р
SP	81h	Stack Pointer								
DPL	82h	Data Pointer Low Byte								
DPH	83h	Data Pointer High Byte								

#### Table 3. System Management SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
PCON	87h	Power Control	SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL
AUXR	8Eh	Auxiliary Register 0	DPU	-	MO	XRS2	XRS1	XRS0	EXTRAM	AO
AUXR1	A2h	Auxiliary Register 1	-	-	ENBOOT	-	GF3	0	-	DPS
CKRL	97h	Clock Reload Register	CKRL7	CKRL6	CKRL5	CKRL4	CKRL3	CKRL2	CKRL1	CKRL0
CKCKON0	8Fh	Clock Control Register 0	-	WDTX2	PCAX2	SIX2	T2X2	T1X2	T0X2	X2
CKCKON1	AFh	Clock Control Register 1	_	-	-	-	_	-	-	SPIX2

#### Table 4. Interrupt SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
IEN0	A8h	Interrupt Enable Control 0	EA	EC	ET2	ES	ET1	EX1	ET0	EX0
IEN1	B1h	Interrupt Enable Control 1	-	-	-	-	-	ESPI	EI2C	KBD
IPH0	B7h	Interrupt Priority Control High 0	-	PPCH	PT2H	PHS	PT1H	PX1H	PT0H	PX0H
IPL0	B8h	Interrupt Priority Control Low 0	-	PPCL	PT2L	PLS	PT1L	PX1L	PTOL	PX0L
IPH1	B3h	Interrupt Priority Control High 1	-	-	-	-	-	SPIH	IE2CH	KBDH
IPL1	B2h	Interrupt Priority Control Low 1	-	-	-	-	-	SPIL	IE2CL	KBDL

### Table 5. Port SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
P0	80h	8-bit Port 0								
P1	90h	8-bit Port 1								
P2	A0h	8-bit Port 2								
P3	B0h	8-bit Port 3								





### Table 6. Timer SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
TCON	88h	Timer/Counter 0 and 1 Control	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
TMOD	89h	Timer/Counter 0 and 1 Modes	GATE1	C/T1#	M11	M01	GATE0	C/T0#	M10	M00
TL0	8Ah	Timer/Counter 0 Low Byte								
TH0	8Ch	Timer/Counter 0 High Byte								
TL1	8Bh	Timer/Counter 1 Low Byte								
TH1	8Dh	Timer/Counter 1 High Byte								
WDTRST	A6h	Watchdog Timer Reset								
WDTPRG	A7h	Watchdog Timer Program	-	-	-	-	-	WTO2	WTO1	WTO0
T2CON	C8h	Timer/Counter 2 control	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#
T2MOD	C9h	Timer/Counter 2 Mode	-	-	-	-	-	-	T2OE	DCEN
RCAP2H	CBh	Timer/Counter 2 Reload/Capture High Byte								
RCAP2L	CAh	Timer/Counter 2 Reload/Capture Low Byte								
TH2	CDh	Timer/Counter 2 High Byte								
TL2	CCh	Timer/Counter 2 Low Byte								

#### Table 7. PCA SFRs

Mnemo- nic	Add	Name	7	6	5	4	3	2	1	0
CCON	D8h	PCA Timer/Counter Control	CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0
CMOD	D9h	PCA Timer/Counter Mode	CIDL	WDTE	-	-	-	CPS1	CPS0	ECF
CL	E9h	PCA Timer/Counter Low Byte								
СН	F9h	PCA Timer/Counter High Byte								
CCAPM0	DAh	PCA Timer/Counter Mode 0		ECOM0	CAPP0	CAPN0	MAT0	TOG0	PWM0	ECCF0
CCAPM1	DBh	PCA Timer/Counter Mode 1		ECOM1	CAPP1	CAPN1	MAT1	TOG1	PWM1	ECCF1
CCAPM2	DCh	PCA Timer/Counter Mode 2	-	ECOM2	CAPP2	CAPN2	MAT2	TOG2	PWM2	ECCF2
ССАРМЗ	DDh	PCA Timer/Counter Mode 3		ECOM3	CAPP3	CAPN3	MAT3	TOG3	PWM3	ECCF3
CCAPM4	DEh	PCA Timer/Counter Mode 4		ECOM4	CAPP4	CAPN4	MAT4	TOG4	PWM4	ECCF4
CCAP0H	FAh	PCA Compare Capture Module 0 H	CCAP0H7	CCAP0H6	CCAP0H5	CCAP0H4	CCAP0H3	CCAP0H2	CCAP0H1	CCAP0H0
CCAP1H	FBh	PCA Compare Capture Module 1 H	CCAP1H7	CCAP1H6	CCAP1H5	CCAP1H4	CCAP1H3	CCAP1H2	CCAP1H1	CCAP1H0
CCAP2H	FCh	PCA Compare Capture Module 2 H	CCAP2H7	CCAP2H6	CCAP2H5	CCAP2H4	CCAP2H3	CCAP2H2	CCAP2H1	CCAP2H0
ССАРЗН	FDh	PCA Compare Capture Module 3 H	CCAP3H7	CCAP3H6	CCAP3H5	CCAP3H4	CCAP3H3	CCAP3H2	CCAP3H1	CCAP3H0
CCAP4H	FEh	PCA Compare Capture Module 4 H	CCAP4H7	CCAP4H6	CCAP4H5	CCAP4H4	CCAP4H3	CCAP4H2	CCAP4H1	CCAP4H0
CCAP0L	EAh	PCA Compare Capture Module 0 L	CCAP0L7	CCAP0L6	CCAP0L5	CCAP0L4	CCAP0L3	CCAP0L2	CCAP0L1	CCAP0L0
CCAP1L	EBh	PCA Compare Capture Module 1 L	CCAP1L7	CCAP1L6	CCAP1L5	CCAP1L4	CCAP1L3	CCAP1L2	CCAP1L1	CCAP1L0
CCAP2L	ECh	PCA Compare Capture Module 2 L	CCAP2L7	CCAP2L6	CCAP2L5	CCAP2L4	CCAP2L3	CCAP2L2	CCAP2L1	CCAP2L0
CCAP3L	EDh	PCA Compare Capture Module 3 L	CCAP3L7	CCAP3L6	CCAP3L5	CCAP3L4	CCAP3L3	CCAP3L2	CCAP3L1	CCAP3L0
CCAP4L	EEh	PCA Compare Capture Module 4 L	CCAP4L7	CCAP4L6	CCAP4L5	CCAP4L4	CCAP4L3	CCAP4L2	CCAP4L1	CCAP4L0

## AT89C51RB2/RC2

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#### Table 8. Serial I/O Port SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
SCON	98h	Serial Control	FE/SM0	SM1	SM2	REN	TB8	RB8	ТІ	RI
SBUF	99h	Serial Data Buffer								
SADEN	B9h	Slave Address Mask								
SADDR	A9h	Slave Address								
BDRCON	9Bh	Baud Rate Control				BRR	ТВСК	RBCK	SPD	SRC
BRL	9Ah	Baud Rate Reload								

### Table 9. SPI Controller SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
SPCON	C3h	SPI Control	SPR2	SPEN	SSDIS	MSTR	CPOL	СРНА	SPR1	SPR0
SPSTA	C4h	SPI Status	SPIF	WCOL	SSERR	MODF	-	-	-	-
SPDAT	C5h	SPI Data	SPD7	SPD6	SPD5	SPD4	SPD3	SPD2	SPD1	SPD0

#### Table 10. Keyboard Interface SFRs

Mnemonic	Add	Name	7	6	5	4	3	2	1	0
KBLS	9Ch	Keyboard Level Selector	KBLS7	KBLS6	KBLS5	KBLS4	KBLS3	KBLS2	KBLS1	KBLS0
KBE	9Dh	Keyboard Input Enable	KBE7	KBE6	KBE5	KBE4	KBE3	KBE2	KBE1	KBE0
KBF	9Eh	Keyboard Flag Register	KBF7	KBF6	KBF5	KBF4	KBF3	KBF2	KBF1	KBF0





Table 11 shows all SFRs with their address and their reset value.

#### Table 11. SFR Mapping

	Bit addressable				Non Bit addre	ssable			
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h		CH 0000 0000	CCAP0H XXXX	CCAP1H XXXX	CCAPL2H XXXX	CCAPL3H XXXX	CCAPL4H XXXX		FFh
F0h	B 0000 0000								F7h
E8h		CL 0000 0000	CCAP0L XXXX XXXX	CCAP1L XXXX XXXX	CCAPL2L XXXX XXXX	CCAPL3L XXXX XXXX	CCAPL4L XXXX XXXX		EFh
E0h	ACC 0000 0000								E7h
D8h	CCON 00X0 0000	CMOD 00XX X000	CCAPM0 X000 0000	CCAPM1 X000 0000	CCAPM2 X000 0000	CCAPM3 X000 0000	CCAPM4 X000 0000		DFh
D0h	PSW 0000 0000	FCON <sup>(1)</sup> XXXX 0000							D7h
C8h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh
C0h				SPCON 0001 0100	SPSTA 0000 0000	SPDAT XXXX XXXX			C7h
B8h	IPL0 X000 000	SADEN 0000 0000							BFh
B0h	P3 1111 1111	IEN1 XXXXX 000	IPL1 XXXXX000	IPH1 XXXX X000				IPH0 X000 0000	B7h
A8h	IEN0 0000 0000	SADDR 0000 0000						CKCON1 XXXX XXX0	AFh
A0h	P2 1111 1111		AUXR1 XXXXX0X0				WDTRST XXXX XXXX	WDTPRG XXXX X000	A7h
98h	SCON 0000 0000	SBUF XXXX XXXX	BRL 0000 0000	BDRCON XXX0 0000	KBLS 0000 0000	KBE 0000 0000	KBF 0000 0000		9Fh
90h	P1 1111 1111							CKRL 1111 1111	97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR XX0X 0000	CKCON0 0000 0000	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	

1. FCON access is reserved for the Flash API and ISP software.

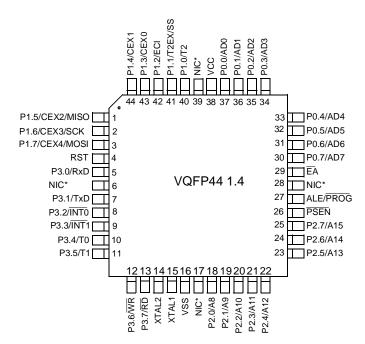
Reserved

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### **Pin Configurations**

### Figure 2. Pin Configurations

P1.2/ECI P1.3CEX0 P1.4/CEX1 P1.5/CEX2/MISO P1.6/CEX3/SCK P1.7CEX4/MOSI P3.0/RxD P3.0/RxD P3.1/TxD P3.2/INT0 P3.3/INT1 P3.4/T0 P3.5/T1 P3.6/WR P3.7/RD	8 9 10	40 39 38 37 36 35 34 33 32 DIL40 30 29 28 27 26 25 24 23	P0.0/AD0 P0.1/AD1 P0.2/AD2 P0.3/AD3 P0.4/AD4 P0.5/AD5 P0.6/AD6 P0.7/AD7 EA ALE/PROG PSEN P2.7/A15 P2.6/A14 P2.5/A13 P2.4/A12 P2.3/A11 P2.3/A11	18 19 20 21 22 23 24 25 26 27 28	] P0.4/AD4 ] P0.5/AD5 ] P0.6/AD6 ] P0.7/AD7 ] EA ] NIC* ] ALE/PROG ] PSEN ] P2.7/A15 ] P2.6/A14 ] P2.5/A13
XTAL1	18 19 20	23 22 21	P2.1/A9	P3.6/WR P3.7/RD XTAL2[ XTAL1[ VSS[ P2.0/A8] P2.1/A9[ P2.4/A12] P2.4/A12]	



\*NIC: No Internal Connection



4180E-8051-10/06



		Pin Num	ıber		
Mnemonic	DIL	LCC	VQFP44 1.4	Туре	Name and Function
V <sub>SS</sub>	20	22	16	I	Ground: 0V reference
V <sub>cc</sub>	40	44	38	I	<b>Power Supply</b> : This is the power supply voltage for normal, idle and power-down operation
P0.0 - P0.7	39 - 32	43 - 36	37 - 30	I/O	<b>Port 0</b> : Port 0 is an open-drain, bi-directional I/O port. Port 0 pins that have 1s written to them float and can be used as high impedance inputs. Port 0 must be polarized to $V_{CC}$ or $V_{SS}$ in order to prevent any parasitic current consumption. Port 0 is also the multiplexed low-order address and data bus during access to external program and data memory. In this application, it uses strong internal pull-up when emitting 1s. Port 0 also inputs the code Bytes during Flash programming. External pull-ups are required during program verification during which P0 outputs the code Bytes.
P1.0 - P1.7	1 - 8	2 - 9	40 - 44 1 - 3	I/O	<b>Port 1</b> : Port 1 is an 8-bit bi-directional I/O port with internal pull-ups. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 1 pins that are externally pulled low will source current because of the internal pull-ups. Port 1 also receives the low-order address Byte during memory programming and verification. Alternate functions for AT89C51RB2/RC2 Port 1 include:
	1	2	40	I/O	P1.0: Input/Output
				I/O	T2 (P1.0): Timer/Counter 2 external count input/Clockout
	2	3	41	I/O	P1.1: Input/Output
				I	T2EX: Timer/Counter 2 Reload/Capture/Direction Control
				I	SS: SPI Slave Select
	3	4	42	I/O	P1.2: Input/Output
				I	ECI: External Clock for the PCA
	4	5	43	I/O	P1.3: Input/Output
				I/O	CEX0: Capture/Compare External I/O for PCA Module 0
	5	6	44	I/O	P1.4: Input/Output
				I/O	CEX1: Capture/Compare External I/O for PCA Module 1
	6	7	1	I/O	P1.5: Input/Output
				I/O	CEX2: Capture/Compare External I/O for PCA Module 2
				I/O	MISO: SPI Master Input Slave Output line
					When SPI is in master mode, MISO receives data from the slave peripheral. When SPI is in slave mode, MISO outputs data to the master controller.
	7	8	2	I/O	P1.6: Input/Output
				I/O	CEX3: Capture/Compare External I/O for PCA Module 3
				I/O	SCK: SPI Serial Clock
					SCK outputs clock to the slave peripheral
	8	9	3	I/O	P1.7: Input/Output:

#### Table 12. Pin Description for 40 - 44 Pin Packages

Table 12.	Pin Description	for 40 - 44 Pin Packages	(Continued)
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		Pin Num	nber			
Mnemonic	DIL	LCC	VQFP44 1.4	Туре	Name and Function	
				I/O	CEX4: Capture/Compare External I/O for PCA Module 4	
P1.0 - P1.7				I/O	MOSI: SPI Master Output Slave Input line	
					When SPI is in master mode, MOSI outputs data to the slave peripheral. When SPI is in slave mode, MOSI receives data from the master controller.	
XTAL1	19	21	15	I	<b>Crystal 1:</b> Input to the inverting oscillator amplifier and input to the internal clock generator circuits.	
XTAL2	18	20	14	0	Crystal 2: Output from the inverting oscillator amplifier	
P2.0 - P2.7	21 - 28	24 - 31	18 - 25	I/O	<b>Port 2</b> : Port 2 is an 8-bit bi-directional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally pulled low will source current because of the internal pull-ups. Port 2 emits the high - order address Byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX @Ri), port 2 emits the contents of the P2 SFR. Some Port 2 pins receive the high order address bits during EPROM programming and verification: P2.0 to P2.5 for 16 KB devices P2.0 to P2.6 for 32KB devices	
P3.0 - P3.7	10 - 17	11, 13 - 19	5, 7 - 13	I/O	<b>Port 3:</b> Port 3 is an 8-bit bi-directional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally pulled low will source current because of the internal pull-ups. Port 3 also serves the special features of the 80C51 family, as listed below.	
	10	11	5	I	RXD (P3.0): Serial input port	
	11	13	7	0	TXD (P3.1): Serial output port	
	12	14	8	I	INT0 (P3.2): External interrupt 0	
	13	15	9	I	INT1 (P3.3): External interrupt 1	
	14	16	10	I	T0 (P3.4): Timer 0 external input	
	15	17	11	I	T1 (P3.5): Timer 1 external input	
	16	18	12	0	WR (P3.6): External data memory write strobe	
	17	19	13	0	RD (P3.7): External data memory read strobe	
RST	9	10	4	I/O	<b>Reset:</b> A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to $V_{SS}$ permits a power-on reset using only an external capacitor to $V_{CC}$ . This pin is an output when the hardware watchdog forces a system reset.	
ALE/PROG	30	33	27	O (I)	Address Latch Enable/Program Pulse: Output pulse for latching the low Byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 (1/3 in X2 mode) the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during Flash programming. ALE can be disabled by setting SFR's AUXR. 0 bit. With this bit set, ALE will be inactive during internal fetches.	





#### **Table 12.** Pin Description for 40 - 44 Pin Packages (Continued)

		Pin Num	lber		
Mnemonic	DIL	LCC	VQFP44 1.4	Туре	Name and Function
PSEN	29	32	26	0	<b>Program Strobe Enable:</b> The read strobe to external program memory. When executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
EA	31	35	29	I	<b>External Access Enable:</b> $\overline{EA}$ must be externally held low to enable the device to fetch code from external program memory locations 0000H to FFFFH (RD). If security level 1 is programmed, $\overline{EA}$ will be internally latched on Reset.

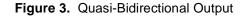
### **Port Types**

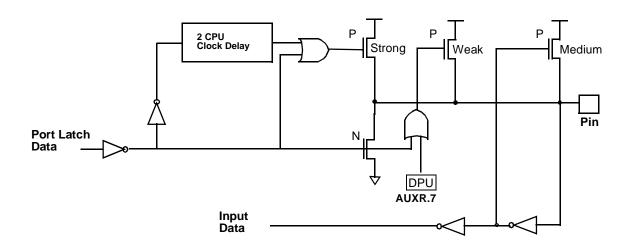
AT89C51RB2/RC2 I/O ports (P1, P2, P3) implement the guasi-bidirectional output that is common on the 80C51 and most of its derivatives. This output type can be used as both an input and output without the need to reconfigure the port. This is possible because when the port outputs a logic high, it is weakly driven, allowing an external device to pull the pin low. When the pin is pulled low, it is driven strongly and able to sink a fairly large current. These features are somewhat similar to an open drain output except that there are three pull-up transistors in the guasi-bidirectional output that serve different purposes. One of these pull-ups, called the "weak" pull-up, is turned on whenever the port latch for the pin contains a logic 1. The weak pull-up sources a very small current that will pull the pin high if it is left floating. A second pull-up, called the "medium" pull-up, is turned on when the port latch for the pin contains a logic 1 and the pin itself is also at a logic 1 level. This pull-up provides the primary source current for a quasi-bidirectional pin that is outputting a 1. If a pin that has a logic 1 on it is pulled low by an external device, the medium pull-up turns off, and only the weak pull-up remains on. In order to pull the pin low under these conditions, the external device has to sink enough current to overpower the medium pull-up and take the voltage on the port pin below its input threshold.

The third pull-up is referred to as the "strong" pull-up. This pull-up is used to speed up low-to-high transitions on a quasi-bidirectional port pin when the port latch changes from a logic 0 to a logic 1. When this occurs, the strong pull-up turns on for a brief time, two CPU clocks, in order to pull the port pin high quickly. Then it turns off again.

The DPU bit (bit 7 in AUXR register) allows to disable the permanent weak pull up of all ports when latch data is logical 0.

The quasi-bidirectional port configuration is shown in Figure 3.









### Oscillator

To optimize the power consumption and execution time needed for a specific task, an internal, prescaler feature has been implemented between the oscillator and the CPU and peripherals.

### Registers

#### Table 13. CKRL Register

CKRL - Clock Reload Register (97h)

7		6	5	4	3	2	1	0
CKRL7	C	KRL6	CKRL5	CKRL4	CKRL3	CKRL2	CKRL1	CKRL0
Bit Numb	er	Mne	emonic	Description				
7:0		(	CKRL	Clock Reload Prescaler value	-			

Reset Value = 1111 1111b

Not bit addressable

#### Table 14. PCON Register

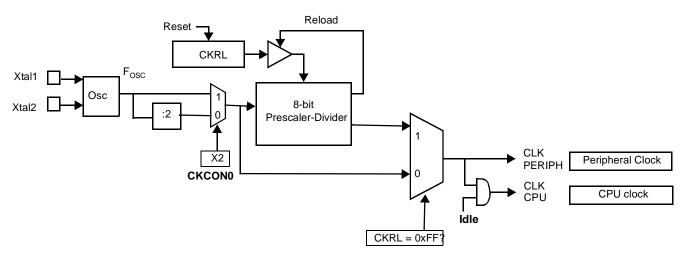
PCON - Power Control Register (87h)

7	6	5		4	3	2	1	0						
SMOD1	SMOD	10D0 -		POF GF1 GF0 PD IDL										
Bit Numb	er B	it Mnemoni	ic I	Description										
7	7 SMOD1			Serial Port Mode bit 1 Set to select double baud rate in mode 1, 2 or 3.										
6		SMOD0		SMOD0 SMOD0 St to select SM0 bit in SCON register.		Cleared to select SM0 bit in SCON register.								
5		-		<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.										
4		POF	(	Power-off Flag Cleared to recognize next reset type. Set by hardware when $V_{CC}$ rises from 0 to its nominal voltage. Can also be set by software.										
3		GF1	(	General-purp Cleared by sof Set by software	tware for gene		0							
2	GF0		(	General-purpose Flag Cleared by software for general-purpose usage. Set by software for general-purpose usage.										
1		PD	(	Power-down Mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.										
0		IDL	(	dle Mode bit Cleared by har Set to enter idl		nterrupt or res	et occurs.							

Reset Value = 00X1 0000b Not bit addressable

### Functional Block Diagram

Figure 4. Functional Oscillator Block Diagram



#### **Prescaler Divider**

- A hardware RESET puts the prescaler divider in the following state:
  - CKRL = FFh:  $F_{CLK CPU} = F_{CLK PERIPH} = F_{OSC}/2$  (Standard C51 feature)
- Any value between FFh down to 00h can be written by software into CKRL register in order to divide frequency of the selected oscillator:
  - CKRL = 00h: minimum frequency  $F_{CLK CPU} = F_{CLK PERIPH} = F_{OSC}/1020$  (Standard Mode)  $F_{CLK CPU} = F_{CLK PERIPH} = F_{OSC}/510$  (X2 Mode)
  - CKRL = FFh: maximum frequency  $F_{CLK CPU} = F_{CLK PERIPH} = F_{OSC}/2$  (Standard Mode)  $F_{CLK CPU} = F_{CLK PERIPH} = F_{OSC}$  (X2 Mode)

 $F_{CLK\,CPU}$  and  $F_{CLK\,PERIPH}$ 

In X2 Mode, for CKRL<>0xFF:  $F_{CPU} = F_{CLKPERIPH} = \frac{F_{OSC}}{2 \times (255 - CKRL)}$ 

In X1 Mode, for CKRL<>0xFF then:  $F_{CPU} = F_{CLKPERIPH} = \frac{F_{OSC}}{4 \times (255 - CKRL)}$ 





### Enhanced Features

In comparison to the original 80C52, the AT89C51RB2/RC2 implements some new features, which are:

- X2 option
- Dual Data Pointer
- Extended RAM
- Programmable Counter Array (PCA)
- Hardware Watchdog
- SPI interface
- 4-level interrupt priority system
- power-off flag
- ONCE mode
- ALE disabling
- Some enhanced features are also located in the UART and the timer 2

X2 Feature

The AT89C51RB2/RC2 core needs only 6 clock periods per machine cycle. This feature called 'X2' provides the following advantages:

- Divide frequency crystals by 2 (cheaper crystals) while keeping same CPU power.
- Save power consumption while keeping same CPU power (oscillator power saving).
- Save power consumption by dividing dynamically the operating frequency by 2 in operating and idle modes.
- Increase CPU power by 2 while keeping same crystal frequency.

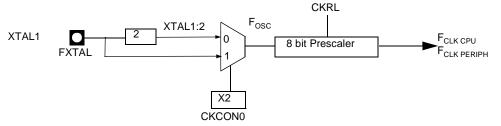
In order to keep the original C51 compatibility, a divider by 2 is inserted between the XTAL1 signal and the main clock input of the core (phase generator). This divider may be disabled by software.

**Description** The clock for the whole circuit and peripherals is first divided by 2 before being used by the CPU core and the peripherals.

This allows any cyclic ratio to be accepted on XTAL1 input. In X2 mode, as this divider is bypassed, the signals on XTAL1 must have a cyclic ratio between 40 to 60%.

Figure 5 shows the clock generation block diagram. X2 bit is validated on the rising edge of the XTAL1+2 to avoid glitches when switching from X2 to X1 mode. Figure 6 shows the switching mode waveforms.

Figure 5. Clock Generation Diagram



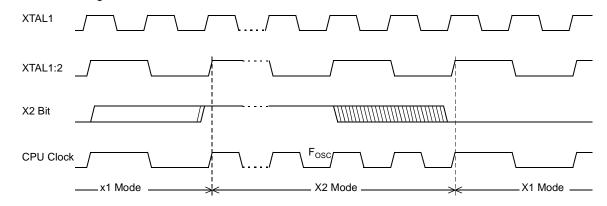


Figure 6. Mode Switching Waveforms

The X2 bit in the CKCON0 register (see Table 15) allows a switch from 12 clock periods per instruction to 6 clock periods and vice versa. At reset, the speed is set according to X2 bit of Hardware Security Byte (HSB). By default, Standard mode is active. Setting the X2 bit activates the X2 feature (X2 mode).

The T0X2, T1X2, T2X2, UARTX2, PCAX2, and WDX2 bits in the CKCON0 register (Table 15) and SPIX2 bit in the CKCON1 register (see Table 16) allow a switch from standard peripheral speed (12 clock periods per peripheral clock cycle) to fast peripheral speed (6 clock periods per peripheral clock cycle). These bits are active only in X2 mode.





### Table 15. CKCON0 Register

CKCON0 - Clock Control Register (8Fh)

7	6	5	4	3	2	1	0	
-	WDX2	PCAX2	SIX2	T2X2	T1X2	T0X2	X2	
Bit Number	Bit Mnemonic	Description						
7	Reserved							
6	WDX2	has no effect Cleared to se	bit is validated ). elect 6 clock p	d when the CP periods per per ods per periph	ipheral clock (	cycle.	s low, this bit	
5	PCAX2	(This control has no effect Cleared to se	Programmable Counter Array Clock This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.					
4	SIX2	(This control has no effect Cleared to se	Enhanced UART Clock (Mode 0 and 2) (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.					
3	T2X2	has no effect Cleared to se	bit is validated ). elect 6 clock p	d when the CP periods per per ods per periph	ipheral clock	cycle.	s low, this bit	
2	T1X2	has no effect	bit is validated ). lect 6 clock p	d when the CP eriods per peri ck cycle.				
1	T0X2	Timer0 Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.						
0	X2	and all the permode) and to	eripherals. Se enable the ir er Power-up r	periods per m t to select 6 cl ndividual perip regarding Hard	ock periods periods periods periods periods periods and the second second second second second second second se	er machine cy . Programme	cle (X2 d by	

Reset Value = 0000 000'HSB. X2'b (see Table 65 "Hardware Security Byte") Not bit addressable

### Table 16. CKCON1 Register

CKCON1 - Clock Control Register (AFh)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	SPIX2
Bit Number	Bit Mnemonic	Description					
7	-	Reserved					
6	-	Reserved					
5	-	Reserved					
4	-	Reserved					
3	-	Reserved					
2	-	Reserved					
1	-	Reserved					
0	SPIX2	this bit has no Clear to selec	o effect). ct 6 clock peri	dated when th ods per peripl ods per periph	neral clock cyc	cle.	n X2 is low,

Reset Value = XXXX XXX0b Not bit addressable

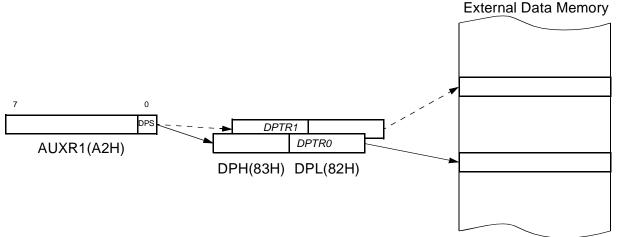


### Dual Data Pointer Register (DPTR)

The additional data pointer can be used to speed up code execution and reduce code size.

The dual DPTR structure is a way by which the chip will specify the address of an external data memory location. There are two 16-bit DPTR registers that address the external memory, and a single bit called DPS = AUXR1.0 (see Table 17) that allows the program code to switch between them (see Figure 7).

### Figure 7. Use of Dual Pointer



#### Table 17. AUXR1 register

AUXR1- Auxiliary Register 1(0A2h)

7	6	5	4	3	2	1	0
-	-	ENBOOT	-	GF3	0	-	DPS
Bit Number	Bit Mnemonic	Description					
7	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not se	et this bit.	
6	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not se	et this bit.	
5	ENBOOT	Enable Boot Cleared to dis Set to map th	sable boot RC	DM. between F800	h - 0FFFFh.		
4	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not se	et this bit.	
3	GF3	This bit is a	general-pur	oose user flag	<b>j.</b> <sup>(1)</sup>		
2	0	Always Clea	red				
1	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not se	et this bit.	
0	DPS	Data Pointer Cleared to se Set to select	elect DPTR0.				

Reset Value = XXXX XX0X0b

#### Not bit addressable

Note: 1. Bit 2 stuck at 0; this allows using INC AUXR1 to toggle DPS without changing GF3.

#### ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Modifies DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added

00A2 AUXR1 EQU 0A2H

0000 909000MOV DPTR,#SOURCE ; address of SOURCE 0003 05A2 INC AUXR1 ; switch data pointers 0005 90A000 MOV DPTR,#DEST ; address of DEST 0008 LOOP: 0008 05A2 INC AUXR1 ; switch data pointers 000A E0 MOVX A,@DPTR ; get a Byte from SOURCE 000B A3 INC DPTR ; increment SOURCE address 000C 05A2 INC AUXR1 ; switch data pointers 000E F0 MOVX @DPTR,A ; write the Byte to DEST 000F A3 INC DPTR ; increment DEST address 0010 70F6JNZ LOOP ; check for 0 terminator 0012 05A2 INC AUXR1 ; (optional) restore DPS





INC is a short (2 Bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.

### Expanded RAM (XRAM)

The AT89C51RB2/RC2 provides additional bytes of random access memory (RAM) space for increased data parameter handling and high-level language usage.

AT89C51RB2/RC2 devices have expanded RAM in external data space; maximum size and location are described in Table 18.

		Addre	ess
Part Number	XRAM Size	Start	End
AT89C51RB2/RC2	1024	00h	3FFh

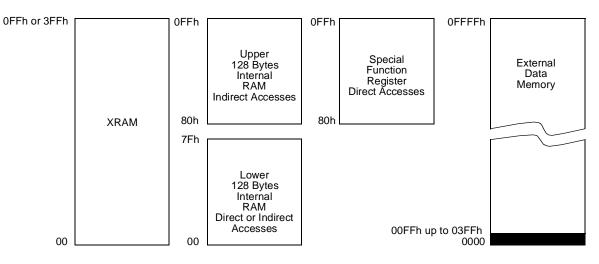
The AT89C51RB2/RC2 has internal data memory that is mapped into four separate segments.

The four segments are:

- 1. The Lower 128 Bytes of RAM (addresses 00h to 7Fh) are directly and indirectly addressable.
- The Upper 128 Bytes of RAM (addresses 80h to FFh) are indirectly addressable only.
- 3. The Special Function Registers, SFRs, (addresses 80h to FFh) are directly addressable only.
- 4. The expanded RAM Bytes are indirectly accessed by MOVX instructions, and with the EXTRAM bit cleared in the AUXR register (see Table 18).

The lower 128 Bytes can be accessed by either direct or indirect addressing. The Upper 128 Bytes can be accessed by indirect addressing only. The Upper 128 Bytes occupy the same address space as the SFR. That means they have the same address, but are physically separate from SFR space.

Figure 8. Internal and External Data Memory Address



When an instruction accesses an internal location above address 7Fh, the CPU knows whether the access is to the upper 128 Bytes of data RAM or to SFR space by the addressing mode used in the instruction.

 Instructions that use direct addressing access SFR space. For example: MOV 0A0H, # data, accesses the SFR at location 0A0h (which is P2).





- Instructions that use indirect addressing access the Upper 128 Bytes of data RAM. For example: MOV @R0, # data where R0 contains 0A0h, accesses the data Byte at address 0A0h, rather than P2 (whose address is 0A0h).
- The XRAM Bytes can be accessed by indirect addressing, with EXTRAM bit cleared and MOVX instructions. This part of memory that is physically located on-chip, logically occupies the first Bytes of external data memory. The bits XRS0 and XRS1 are used to hide a part of the available XRAM as explained in Table 18. This can be useful if external peripherals are mapped at addresses already used by the internal XRAM.
- With <u>EXTRAM = 0</u>, the XRAM is indirectly addressed, using the MOVX instruction in combination with any of the registers R0, R1 of the selected bank or DPTR. An access to XRAM will not affect ports P0, P2, P3.6 (WR) and P3.7 (RD). For example, with EXTRAM = 0, MOVX @R0, # data where R0 contains 0A0H, accesses the XRAM at address 0A0H rather than external memory. An access to external data memory locations higher than the accessible size of the XRAM will be performed with the MOVX DPTR instructions in the same way as in the standard 80C51, with P0 and P2 as data/address busses, and P3.6 and P3.7 as write and read timing signals. Accesses to XRAM above 0FFH can only be done by the use of DPTR.
- With <u>EXTRAM = 1</u>, MOVX @RI and MOVX @DPTR will be similar to the standard 80C51. MOVX @ Ri will provide an eight-bit address multiplexed with data on Port0 and any output port pins can be used to output higher order address bits. This is to provide the external paging capability. MOVX @DPTR will generate a sixteen-bit address. Port2 outputs the high-order eight address bits (the contents of DPH) while Port0 multiplexes the low-order eight address bits (DPL) with data. MOVX @ RI and MOVX @DPTR will generate either read or write signals on P3.6 (WR) and P3.7 (RD).

The stack pointer (SP) may be located anywhere in the 256 Bytes RAM (lower and upper RAM) internal data memory. The stack may not be located in the XRAM.

The M0 bit allows to stretch the XRAM timings; if M0 is set, the read and write pulses are extended from 6 to 30 clock periods. This is useful to access external slow peripherals.

### Registers

### Table 19. AUXR Register

AUXR - Auxiliary Register (8Eh)

7	6	5	4	3	2	1	0
DPU	-	МО	-	XRS1	XRS0	EXTRAM	AO
Bit Number	Bit Mnemonic	Description					
7	DPU		ctivate the per	manent weak bull-up (reduce		latch data is lo umption)	ogical 1
6	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not s	et this bit.	
5	МО	periods (defa	retch MOVX o uult).			R pulse length i se length is 30	
4	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not s	et this bit.	
3	XRS1	XRAM Size					
2	XRS0	XRS1         XRS           0         0           0         1           1         0           1         1	0 XRAM size 256 Bytes 512 Bytes 768 Bytes 1024 Bytes	(default)			
1	EXTRAM	Set to access Programmed	ccess internal s external me	after Power-u		DPTR. Iardware Secu	rity Byte
0	AO		is emitted at ised). (default			scillator freque ring a MOVX o	

Reset Value = XX0X 00'HSB. XRAM'0b (see Table 65) Not bit addressable



Timer 2	The Timer 2 in the AT89C51RB2/RC2 is the standard C52 Timer 2.
	It is a 16-bit timer/counter: the count is maintained by two eight-bit timer registers, TH2 and TL2 are cascaded. It is controlled by T2CON (Table 20) and T2MOD (Table 21) registers. Timer 2 operation is similar to Timer 0 and Timer 1C/T2 selects $F_{OSC}$ /12 (timer operation) or external pin T2 (counter operation) as the timer clock input. Setting TR2 allows TL2 to increment by the selected input.
	Timer 2 has 3 operating modes: capture, autoreload and Baud Rate Generator. These modes are selected by the combination of RCLK, TCLK and CP/RL2 (T2CON).
	see the Atmel 8-bit Microcontroller Hardware description for the description of Capture and Baud Rate Generator Modes.
	Timer 2 includes the following enhancements:
	Auto-reload mode with up or down counter
	Programmable clock-output
Auto-reload Mode	The auto-reload mode configures Timer 2 as a 16-bit timer or event counter with auto- matic reload. If DCEN bit in T2MOD is cleared, Timer 2 behaves as in 80C52 (see the Atmel C51 Microcontroller Hardware description). If DCEN bit is set, Timer 2 acts as an Up/down timer/counter as shown in Figure 9. In this mode the T2EX pin controls the direction of count.
	When T2EX is high, Timer 2 counts up. Timer overflow occurs at FFFFh which sets the TF2 flag and generates an interrupt request. The overflow also causes the 16-bit value in RCAP2H and RCAP2L registers to be loaded into the timer registers TH2 and TL2.
	When T2EX is low, Timer 2 counts down. Timer underflow occurs when the count in the timer registers TH2 and TL2 equals the value stored in RCAP2H and RCAP2L registers. The underflow sets TF2 flag and reloads FFFFh into the timer registers.
	The EXF2 bit toggles when Timer 2 overflows or underflows according to the direction of the count. EXF2 does not generate any interrupt. This bit can be used to provide 17-bit resolution.

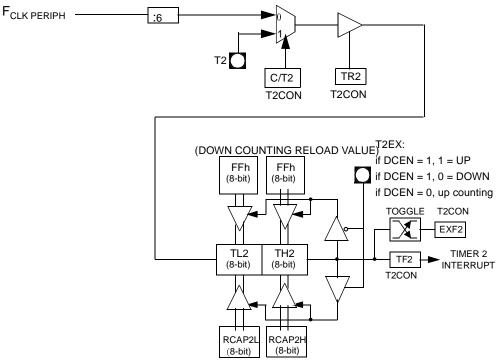


Figure 9. Auto-Reload Mode Up/Down Counter (DCEN = 1)



# **Programmable Clock-out Mode** In the clock-out mode, Timer 2 operates as a 50% duty-cycle, programmable clock generator (see Figure 10). The input clock increments TL2 at frequency F<sub>CLK PERIPH</sub>/2. The timer repeatedly counts to overflow from a loaded value. At overflow, the contents of RCAP2H and RCAP2L registers are loaded into TH2 and TL2. In this mode, Timer 2 overflows do not generate interrupts. The formula gives the clock-out frequency as a function of the system oscillator frequency and the value in the RCAP2H and RCAP2L registers:

 $Clock-OutFrequency = \frac{F_{CLKPERIPH}}{4 \times (65536 - RCAP2H/RCAP2L)}$ 

For a 16 MHz system clock, Timer 2 has a programmable frequency range of 61 Hz  $(F_{CLK PERIPH}/2^{16})$  to 4 MHz  $(F_{CLK PERIPH}/4)$ . The generated clock signal is brought out to T2 pin (P1.0).

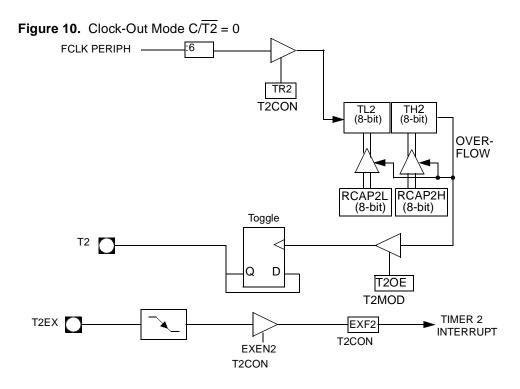
Timer 2 is programmed for the clock-out mode as follows:

- Set T2OE bit in T2MOD register.
- Clear C/T2 bit in T2CON register.
- Determine the 16-bit reload value from the formula and enter it in RCAP2H/RCAP2L registers.
- Enter a 16-bit initial value in timer registers TH2/TL2. It can be the same as the reload value or a different one depending on the application.
- To start the timer, set TR2 run control bit in T2CON register.

It is possible to use Timer 2 as a baud rate generator and a clock generator simultaneously. For this configuration, the baud rates and clock frequencies are not independent since both functions use the values in the RCAP2H and RCAP2L registers.







### Registers

### Table 20. T2CON Register

T2CON - Timer 2 Control Register (C8h)

7	6	5	4	3	2	1	0			
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#			
Bit Number	Bit Mnemonic	Description	Description							
7	TF2	Must be clea	<b>Fimer 2 Overflow Flag</b> Must be cleared by software. Set by hardware on Timer 2 overflow, if RCLK = 0 and TCLK = 0.							
6	EXF2	Set when a c EXEN2 = 1. When set, ca interrupt is e Must be clear	<b>Timer 2 External Flag</b> Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2 = 1. When set, causes the CPU to vector to Timer 2 interrupt routine when Timer 2 interrupt is enabled. Must be cleared by software. EXF2 doesn't cause an interrupt in Up/down counter mode (DCEN = 1).							
5	RCLK	Cleared to us	Receive Clock Bit Cleared to use timer 1 overflow as receive clock for serial port in mode 1 or 3. Set to use Timer 2 overflow as receive clock for serial port in mode 1 or 3.							
4	TCLK	Cleared to us	Transmit Clock Bit Cleared to use timer 1 overflow as transmit clock for serial port in mode 1 or 3. Set to use Timer 2 overflow as transmit clock for serial port in mode 1 or 3.							
3	EXEN2	Cleared to ig Set to cause	<b>Timer 2 External Enable Bit</b> Cleared to ignore events on T2EX pin for Timer 2 operation. Set to cause a capture or reload when a negative transition on T2EX pin is detected, if Timer 2 is not used to clock the serial port.							
2	TR2	Cleared to tu	Timer 2 Run Control Bit Cleared to turn off Timer 2. Set to turn on Timer 2.							
1	C/T2#	Cleared for t Set for count	<b>Timer/Counter 2 Select Bit</b> Cleared for timer operation (input from internal clock system: F <sub>CLK PERIPH</sub> ). Set for counter operation (input from T2 input pin, falling edge trigger). Must be 0 for clock out mode.							
0	CP/RL2#	If RCLK = 1 on Timer 2 o Cleared to an if EXEN2 = 1	Timer 2 Capture/Reload Bit If RCLK = 1 or TCLK = 1, CP/RL2# is ignored and timer is forced to auto-reload on Timer 2 overflow. Cleared to auto-reload on Timer 2 overflows or negative transitions on T2EX pin if EXEN2 = 1. Set to capture on negative transitions on T2EX pin if EXEN2 = 1.							

Reset Value = 0000 0000b Bit addressable





### Table 21. T2MOD Register

T2MOD – Timer 2 Mode Control Register (C9h)

7	6	5	4	3	2	1	0	
-	-	-	-	-	-	T2OE	DCEN	
Bit Number	Bit Mnemonic	Description						
7	-	<b>Reserved</b> The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
6	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
5	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
4	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
3	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
2	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
1	T2OE	Cleared to pr	Timer 2 Output Enable Bitt Cleared to program P1.0/T2 as clock input or I/O port. Set to program P1.0/T2 as clock output.					
0	DCEN	Cleared to di		t as up/down c p/down count				

Reset Value = XXXX XX00b Not bit addressable

### Programmable Counter Array (PCA)

The PCA provides more timing capabilities with less CPU intervention than the standard timer/counters. Its advantages include reduced software overhead and improved accuracy. The PCA consists of a dedicated timer/counter which serves as the time base for an array of five compare/capture Modules. Its clock input can be programmed to count any one of the following signals:

- Peripheral clock frequency (F<sub>CLK PERIPH</sub>) ÷ 6
- Peripheral clock frequency (F<sub>CLK PERIPH</sub>) ÷ 2
- Timer 0 overflow
- External input on ECI (P1.2)

Each compare/capture Modules can be programmed in any one of the following modes:

- Rising and/or falling edge capture
- Software timer
- High-speed output
- Pulse width modulator

Module 4 can also be programmed as a watchdog timer (see Section "PCA Watchdog Timer", page 42).

When the compare/capture Modules are programmed in the capture mode, software timer, or high speed output mode, an interrupt can be generated when the Module executes its function. All five Modules plus the PCA timer overflow share one interrupt vector.

The PCA timer/counter and compare/capture modules share Port 1 for external I/O. These pins are listed below. If one or several bits in the port are not used for the PCA, they can still be used for standard I/O.

PCA Component	External I/O Pin
16-bit Counter	P1.2/ECI
16-bit Module 0	P1.3/CEX0
16-bit Module 1	P1.4/CEX1
16-bit Module 2	P1.5/CEX2
16-bit Module 3	P1.6/CEX3

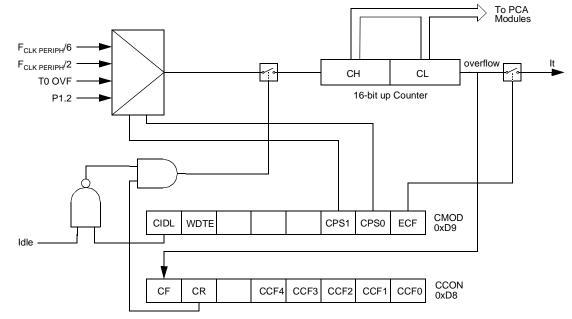
The PCA timer is a common time base for all five Modules (see Figure 11). The timer count source is determined from the CPS1 and CPS0 bits in the CMOD register (Table 22) and can be programmed to run at:

- 1/6 the peripheral clock frequency (F<sub>CLK PERIPH</sub>)
- 1/2 the peripheral clock frequency (F<sub>CLK PERIPH</sub>)
- The Timer 0 overflow
- The input on the ECI pin (P1.2)





### Figure 11. PCA Timer/Counter



### Registers

#### Table 22. CMOD Register

CMOD – PCA Counter Mode Register (D9h)

7	6	5	4	3	2	1	0			
CIDL	WDTE	-	-	-	CPS1	CPS0	ECF			
Bit Number	Bit Mnemonic	Description	Description							
7	CIDL	Cleared to p	<b>Counter Idle Control</b> Cleared to program the PCA Counter to continue functioning during idle Mode. Set to program PCA to be gated off during idle.							
6	WDTE	Cleared to d	Watchdog Timer Enable Cleared to disable Watchdog Timer function on PCA Module 4. Set to enable Watchdog Timer function on PCA Module 4.							
5	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.							
3	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.							
2	CPS1	PCA Count	Pulse Select							
1	CPS0	CPS1         CPSi           0         0           1         0           1         1	0     1     Internal clock F <sub>LK PERIPH</sub> /2       1     0     Timer 0 Overflow							
0	ECF	Cleared to d	isable CF bit i		i <b>pt</b> nibit an interru te an interrupt	•				

Reset Value = 00XX X000b Not bit addressable

The CMOD register includes three additional bits associated with the PCA.

- The CIDL bit which allows the PCA to stop during idle mode.
- The WDTE bit which enables or disables the watchdog function on Module 4.
- The ECF bit which when set causes an interrupt and the PCA overflow flag CF (in the CCON SFR) to be set when the PCA timer overflows.

The CCON register contains the run control bit for the PCA and the flags for the PCA timer (CF) and each Module (see Table 23).

- Bit CR (CCON. 6) must be set by software to run the PCA. The PCA is shut off by clearing this bit.
- Bit CF: The CF bit (CCON. 7) is set when the PCA counter overflows and an interrupt will be generated if the ECF bit in the CMOD register is set. The CF bit can only be cleared by software.
- Bits 0 through 4 are the flags for the Modules (bit 0 for Module 0, bit 1 for Module 1, etc.) and are set by hardware when either a match or a capture occurs. These flags also can only be cleared by software.





#### Table 23. CCON Register

CCON – PCA Counter Control Register (D8h)

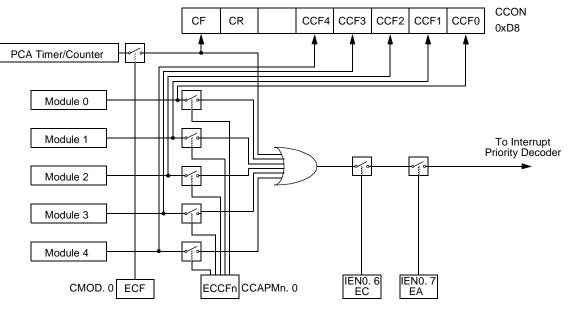
7	6	5	4	3	2	1	0			
CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0			
Bit Number	Bit Mnemonic	Description	Description							
7	CF	Set by hardw CMOD is set	PCA Counter Overflow Flag Set by hardware when the counter rolls over. CF flags an interrupt if bit ECF in CMOD is set. CF may be set by either hardware or software but can only be cleared by software.							
6	CR	Must be clea		ol Bit are to turn the PCA counter		off.				
5	-	Reserved The value re	ad from this b	oit is indetermi	nate. Do not s	et this bit.				
4	CCF4	Must be clea	PCA Module 4 Interrupt Flag Must be cleared by software. Set by hardware when a match or capture occurs.							
3	CCF3	Must be clea	PCA Module 3 Interrupt Flag Must be cleared by software. Set by hardware when a match or capture occurs.							
2	CCF2	Must be clea	PCA Module 2 Interrupt Flag Must be cleared by software. Set by hardware when a match or capture occurs.							
1	CCF1	Must be clea	PCA Module 1 Interrupt Flag Must be cleared by software. Set by hardware when a match or capture occurs.							
0	CCF0	Must be clea	PCA Module 0 Interrupt Flag Must be cleared by software. Set by hardware when a match or capture occurs.							

Reset Value = 000X 0000b Bit addressable

The watchdog timer function is implemented in Module 4 (see Figure 14).

The PCA interrupt system is shown in Figure 12.

#### Figure 12. PCA Interrupt System



**PCA Modules:** each one of the five compare/capture Modules has six possible functions. It can perform:

- 16-bit Capture, positive-edge triggered
- 16-bit Capture, negative-edge triggered
- 16-bit Capture, both positive and negative-edge triggered
- 16-bit Software Timer
- 16-bit High-speed Output
- 8-bit Pulse Width Modulator

In addition, Module 4 can be used as a Watchdog Timer.

Each Module in the PCA has a special function register associated with it. These registers are: CCAPM0 for Module 0, CCAPM1 for Module 1, etc. (see Table 24). The registers contain the bits that control the mode that each Module will operate in.

- The ECCF bit (CCAPMn. 0 where n = 0, 1, 2, 3, or 4 depending on the Module) enables the CCF flag in the CCON SFR to generate an interrupt when a match or compare occurs in the associated Module.
- PWM (CCAPMn. 1) enables the pulse width modulation mode.
- The TOG bit (CCAPMn. 2) when set causes the CEX output associated with the Module to toggle when there is a match between the PCA counter and the Module's capture/compare register.
- The match bit MAT (CCAPMn. 3) when set will cause the CCFn bit in the CCON register to be set when there is a match between the PCA counter and the Module's capture/compare register.
- The next two bits CAPN (CCAPMn. 4) and CAPP (CCAPMn. 5) determine the edge that a capture input will be active on. The CAPN bit enables the negative edge, and the CAPP bit enables the positive edge. If both bits are set both edges will be enabled and a capture will occur for either transition.
- The last bit in the register ECOM (CCAPMn. 6) when set enables the comparator function.

Table 24 shows the CCAPMn settings for the various PCA functions.





 Table 24.
 CCAPMn Registers (n = 0-4)

CCAPM0 – PCA Module 0 Compare/Capture Control Register (0DAh)

CCAPM1 – PCA Module 1 Compare/Capture Control Register (0DBh)

CCAPM2 – PCA Module 2 Compare/Capture Control Register (0DCh)

CCAPM3 – PCA Module 3 Compare/Capture Control Register (0DDh)

CCAPM4 – PCA Module 4 Compare/Capture Control Register (0DEh)

7	6	5	4	3	2	1	0		
-	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn		
Bit Number	Bit Mnemonic	Description	Description						
7	-	<b>Reserved</b> The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.						
6	ECOMn		•	nparator functi itor function.	on.				
5	CAPPn			e edge capture e capture.	).				
4	CAPNn	Cleared to di	Capture Negative Cleared to disable negative edge capture. Set to enable negative edge capture.						
3	MATn		When MATn = 1, a match of the PCA counter with this Module's compare/capture register causes the CCFn bit in CCON to be set, flagging an						
2	TOGn		<b>Toggle</b> When TOGn = 1, a match of the PCA counter with this Module's compare/capture register causes theCEXn pin to toggle.						
1	PWMn	Cleared to di	Pulse Width Modulation Mode Cleared to disable the CEXn pin to be used as a pulse width modulated output. Set to enable the CEXn pin to be used as a pulse width modulated output.						
0	CCF0	Cleared to di an interrupt.	Enable CCF Interrupt Cleared to disable compare/capture flag CCFn in the CCON register to generate an interrupt. Set to enable compare/capture flag CCFn in the CCON register to generate an						

Reset Value = X000 0000b Not bit addressable

ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMm	ECCFn	Module Function
0	0	0	0	0	0	0	No Operation
х	1	0	0	0	0	х	16-bit capture by a positive-edge trigger on CEXn
х	0	1	0	0	0	х	16-bit capture by a negative trigger on CEXn
х	1	1	0	0	0	х	16-bit capture by a transition on CEXn
1	0	0	1	0	0	х	16-bit Software Timer/Compare mode.
1	0	0	1	1	0	Х	16-bit High-speed Output
1	0	0	0	0	1	0	8-bit PWM
1	0	0	1	Х	0	Х	Watchdog Timer (Module 4 only)

Table 25. PCA Module Modes (CCAPMn Registers)

There are two additional registers associated with each of the PCA Modules. They are CCAPnH and CCAPnL and these are the registers that store the 16-bit count when a capture occurs or a compare should occur. When a Module is used in the PWM mode these registers are used to control the duty cycle of the output (see Table 26 and Table 27).

**Table 26.** CCAPnH Registers (n = 0-4)

CCAP0H – PCA Module 0 Compare/Capture Control Register High (0FAh)

CCAP1H – PCA Module 1 Compare/Capture Control Register High (0FBh)

CCAP2H – PCA Module 2 Compare/Capture Control Register High (0FCh)

CCAP3H – PCA Module 3 Compare/Capture Control Register High (0FDh)

CCAP4H – PCA Module 4 Compare/Capture Control Register High (0FEh) .

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7 - 0	-	PCA Module CCAPnH Val		Capture Con	trol		

Reset Value = 0000 0000b Not bit addressable





 Table 27. CCAPnL Registers (n = 0-4)

CCAP0L - PCA Module 0 Compare/Capture Control Register Low (0EAh)

CCAP1L – PCA Module 1 Compare/Capture Control Register Low (0EBh)

CCAP2L – PCA Module 2 Compare/Capture Control Register Low (0ECh)

CCAP3L – PCA Module 3 Compare/Capture Control Register Low (0EDh)

CCAP4L - PCA Module 4 Compare/Capture Control Register Low (0EEh)

7	6	5	4	3	2	1	0		
-	-	-	-	-	-	-	-		
Bit Number	Bit Mnemonic	Description	Description						
7 - 0	-	PCA Module CCAPnL Val		/Capture Con	trol				

Reset Value = 0000 0000b Not bit addressable

#### Table 28. CH Register

CH – PCA Counter Register High (0F9h)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7 - 0	-	PCA Counte CH Value	er				

Reset Value = 0000 0000b Not bit addressable

Table 29. CL Register

CL - PCA Counter Register Low (0E9h)

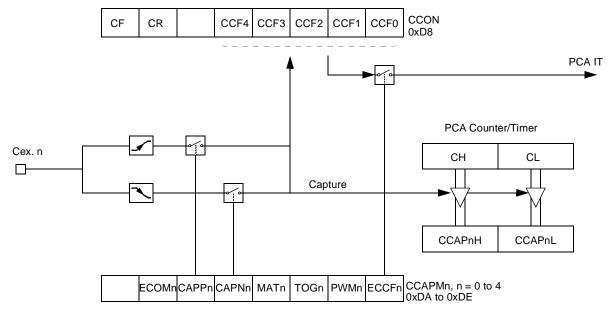
7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7 - 0	-	PCA Counte CL Value	r				

Reset Value = 0000 0000b Not bit addressable

### PCA Capture Mode

To use one of the PCA Modules in the capture mode either one or both of the CCAPM bits CAPN and CAPP for that Module must be set. The external CEX input for the Module (on port 1) is sampled for a transition. When a valid transition occurs the PCA hardware loads the value of the PCA counter registers (CH and CL) into the Module's capture registers (CCAPnL and CCAPnH). If the CCFn bit for the Module in the CCON SFR and the ECCFn bit in the CCAPMn SFR are set then an interrupt will be generated (see Figure 13).





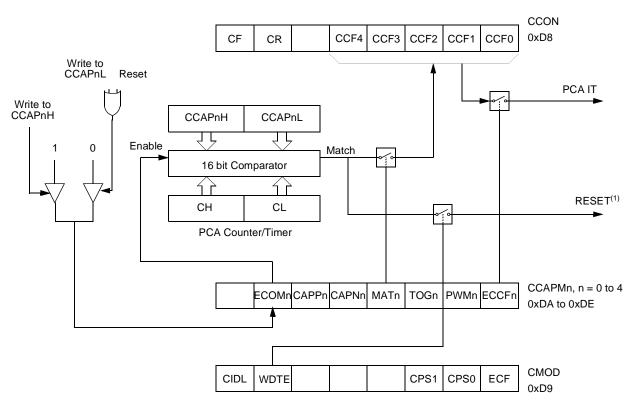


# AIMEL

### 16-bit Software Timer/ Compare Mode

The PCA Modules can be used as software timers by setting both the ECOM and MAT bits in the Modules CCAPMn register. The PCA timer will be compared to the Module's capture registers and when a match occurs, an interrupt will occur if the CCFn (CCON SFR) and the ECCFn (CCAPMn SFR) bits for the Module are both set (see Figure 14).

Figure 14. PCA Compare Mode and PCA Watchdog Timer



Note: 1. Only for Module 4

Before enabling ECOM bit, CCAPnL and CCAPnH should be set with a non zero value, otherwise an unwanted match could occur. Writing to CCAPnH will set the ECOM bit.

Once ECOM set, writing CCAPnL will clear ECOM so that an unwanted match doesn't occur while modifying the compare value. Writing to CCAPnH will set ECOM. For this reason, user software should write CCAPnL first, and then CCAPnH. Of course, the ECOM bit can still be controlled by accessing to CCAPMn register.

### **High-speed Output Mode**

In this mode the CEX output (on port 1) associated with the PCA module will toggle each time a match occurs between the PCA counter and the modules capture registers. To activate this mode the TOG, MAT, and ECOM bits in the modules CCAPMn SFR must be set (see Figure 15).

A prior write must be done to CCAPnL and CCAPnH before writing the ECOMn bit.

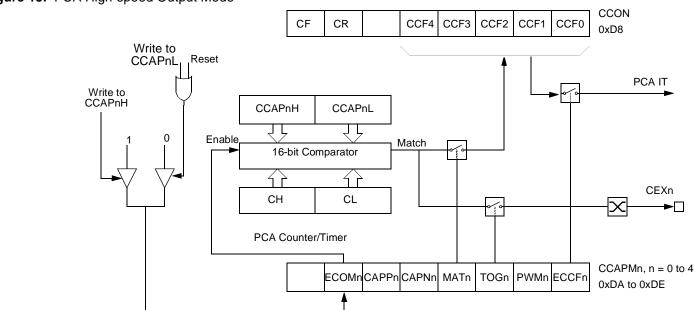


Figure 15. PCA High-speed Output Mode

Before enabling ECOM bit, CCAPnL and CCAPnH should be set with a non-zero value, otherwise an unwanted match could occur.

Once ECOM is set, writing CCAPnL will clear ECOM so that an unwanted match doesn't occur while modifying the compare value. Writing to CCAPnH will set ECOM. For this reason, user software should write CCAPnL first, and then CCAPnH. Of course, the ECOM bit can still be controlled by accessing to CCAPMn register.

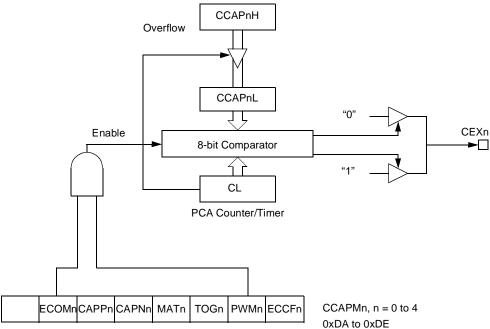




### Pulse Width Modulator Mode

All of the PCA Modules can be used as PWM outputs. Figure 16 shows the PWM function. The frequency of the output depends on the source for the PCA timer. All of the Modules will have the same frequency of output because they all share the PCA timer. The duty cycle of each Module is independently variable using the module's capture register CCAPLn. When the value of the PCA CL SFR is less than the value in the module's CCAPLn SFR the output will be low, when it is equal to or greater than the output will be high. When CL overflows from FF to 00, CCAPLn is reloaded with the value in CCAPHn. This allows updating the PWM without glitches. The PWM and ECOM bits in the module's CCAPMn register must be set to enable the PWM mode.

#### Figure 16. PCA PWM Mode



**PCA Watchdog Timer** An on-board watchdog timer is available with the PCA to improve the reliability of the system without increasing chip count. Watchdog timers are useful for systems that are susceptible to noise, power glitches, or electrostatic discharge. Module 4 is the only PCA Module that can be programmed as a watchdog. However, this Module can still be used for other modes if the watchdog is not needed. Figure 14 shows a diagram of how the watchdog works. The user pre-loads a 16-bit value in the compare registers. Just like the other compare modes, this 16-bit value is compared to the PCA timer value. If a match is allowed to occur, an internal reset will be generated. This will not cause the RST pin to be driven high.

In order to hold off the reset, the user has the following three options:

- 1. Periodically change the compare value so it will never match the PCA timer.
- 2. Periodically change the PCA timer value so it will never match the compare values.
- 3. Disable the watchdog by clearing the WDTE bit before a match occurs and then re-enable it.

The first two options are more reliable because the watchdog timer is never disabled as in option #3. If the program counter ever goes astray, a match will eventually occur and cause an internal reset. The second option is also not recommended if other PCA Modules are being used. Remember, the PCA timer is the time base for all modules;

changing the time base for other Modules would not be a good idea. Thus, in most applications the first solution is the best option.

This watchdog timer won't generate a reset out on the reset pin.





## **Serial I/O Port** The serial I/O port in the AT89C51RB2/RC2 is compatible with the serial I/O port in the 80C52.

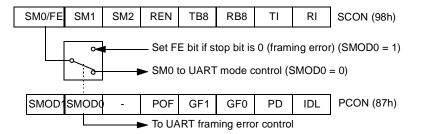
It provides both synchronous and asynchronous communication modes. It operates as a Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simultaneously and at different baud rates

Serial I/O port includes the following enhancements:

- Framing error detection
- Automatic address recognition

**Framing Error Detection** Framing bit error detection is provided for the three asynchronous modes (modes 1, 2 and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON register (See Figure 17).

Figure 17. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Table 33.) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 18. and Figure 19.).



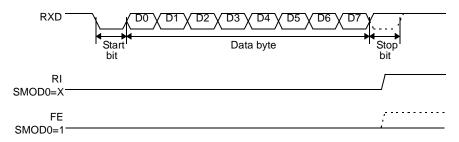


	Figure 19.	UART Timir	UART Timings in Modes 2 and 3				
	RXI	,		<u> D3 V D4 V D5</u>		<u>3</u> <u>1</u> <u>1</u>	
		Start		Data byte	<mark>→ 4</mark> Nir bi		
	RI	bit			л. Г		
	SMOD0=0				/		
	RI SMOD0=1						
	FE					·····	
	SMOD0=1						
Automatic Address Recognition	nication fe Implement communic incoming of receiver set is not inter If desired, this configu the receive by a valid To support a broadcas Note: Th	ature is enab ed in hardwa ation feature command fra ets RI bit in SC rupted by cor the user may uration, the st ed command stop bit. automatic ac st address. e multiprocess	led (SM2 bit in are, automatic e by allowing me. Only whe CON register to mmand frame / enable the a top bit takes th frame address ddress recogn	n SCON register address recogn the serial port en the serial port to generate an in s addressed to d nutomatic address ne place of the n as matches the d nition, a device i	r is set). nition enhance t to examine rt recognizes nterrupt. This other devices. ss recognition inth data bit. E device's addre s identified by ic address reco	feature in mode 1.In Bit RI is set only when ess and is terminated a given address and ognition features cannot	
	be	enabled in mo	ode 0 (i. e. settir	ng SM2 bit in SCC	ON register in m	ode 0 has no effect).	
Given Address	register is device's gi slaves at a To addres 1111b. For examp SA SA	a mask byte ven address. time. The fo s a device b	e that contair The don't-cai llowing examp y its individua	ns don't-care b re bits provide th ble illustrates ho	its (defined b ne flexibility to w a given add	register; the SADEN y zeros) to form the address one or more lress is formed. A byte must be 1111	
	Slave A <u>SA</u>	ng is an exar SADDR1111 000 <u>DEN1111 1010b</u> en1111 0X0Xb	01b	o use given add	resses to add	ress different slaves:	
	SA	SADDR1111 00 <sup>.</sup> DEN1111 1001b en1111 0XX1b					
	<u>SA</u>	SADDR1111 00 <u>DEN1111 1101b</u> ren1111 00X1b					





The SADEN byte is selected so that each slave may be addressed separately. For slave A, bit 0 (the LSB) is a don't-care bit; for slaves B and C, bit 0 is a 1.To communicate with slave A only, the master must send an address where bit 0 is clear (e. g. 1111 0000b).

For slave A, bit 1 is a 1; for slaves B and C, bit 1 is a don't care bit. To communicate with slaves B and C, but not slave A, the master must send an address with bits 0 and 1 both set (e. g. 1111 0011b).

To communicate with slaves A, B and C, the master must send an address with bit 0 set, bit 1 clear, and bit 2 clear (e. g. 1111 0001b).

#### **Broadcast Address**

A broadcast address is formed from the logical OR of the SADDR and SADEN registers with zeros defined as don't-care bits, e. g. : SADDR0101 0110b

SADEN101010100 SADEN1111 1100b Broadcast =SADDR OR SADEN1111 111Xb

The use of don't-care bits provides flexibility in defining the broadcast address, however in most applications, a broadcast address is FFh. The following is an example of using broadcast addresses:

Slave A:SADDR1111 0001b SADEN1111 1010b Broadcast1111 1X11b,

Slave B:SADDR1111 0011b SADEN1111 1001b Broadcast1111 1X11B,

Slave C:SADDR=1111 0011b SADEN1111 1101b Broadcast1111 1111b

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send and address FBh.

Reset AddressesOn reset, the SADDR and SADEN registers are initialized to 00h, i. e. the given and<br/>broadcast addresses are XXXX XXXb (all don't-care bits). This ensures that the serial<br/>port will reply to any address, and so, that it is backwards compatible with the 80C51<br/>microcontrollers that do not support automatic address recognition.



### Registers

Table 30. SADEN Register

SADEN - Slave Address Mask Register (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable

Table 31. SADDR Register

SADDR - Slave Address Register (A9h)

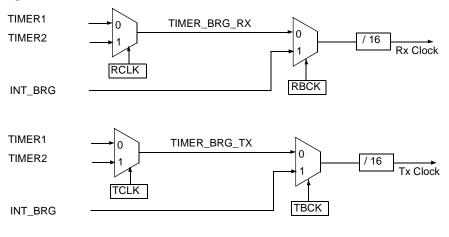
7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable

# Baud Rate Selection for UART for Mode 1 and 3

The Baud Rate Generator for transmit and receive clocks can be selected separately via the T2CON and BDRCON registers.

#### Figure 20. Baud Rate Selection







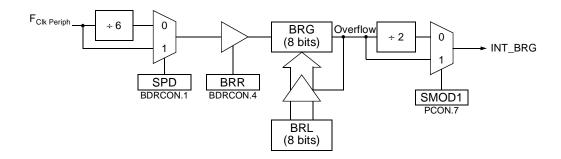
TCLK (T2CON)	RCLK (T2CON)	TBCK (BDRCON)	RBCK (BDRCON)	Clock Source UART Tx	Clock Source UART Rx
0	0	0	0	Timer 1	Timer 1
1	0	0	0	Timer 2	Timer 1
0	1	0	0	Timer 1	Timer 2
1	1	0	0	Timer 2	Timer 2
Х	0	1	0	INT_BRG	Timer 1
Х	1	1	0	INT_BRG	Timer 2
0	Х	0	1	Timer 1	INT_BRG
1	Х	0	1	Timer 2	INT_BRG
Х	х	1	1	INT_BRG	INT_BRG

Table 32. Baud Rate Selection Table UART

## Internal Baud Rate Generator (BRG)

When the internal Baud Rate Generator is used, the Baud Rates are determined by the BRG overflow depending on the BRL reload value, the value of SPD bit (Speed Mode) in BDRCON register and the value of the SMOD1 bit in PCON register.

Figure 21. Internal Baud Rate



• The baud rate for UART is token by formula:

$$Baud_Rate = \frac{2^{SMOD1} \cdot F_{PER}}{6^{(1-SPD)} \cdot 32 \cdot (256 \cdot BRL)}$$
$$BRL = 256 - \frac{2^{SMOD1} \cdot F_{PER}}{6^{(1-SPD)} \cdot 32 \cdot Baud_Rate}$$

### Table 33. SCON Register

SCON - Serial Control Register (98h)

7	6	5	4	3	2	1	0		
FE/SM0	SM1	SM2	REN	TB8	RB8	ТІ	RI		
Bit Number	Bit Mnemo	nic Descr	Description						
7	FE	Clear Set by	hardware wh	ror state, not en an invalid	cleared by a v stop bit is dete cess to the FE	ected.			
	SMO	) Refer	Serial port Mode bit 0 Refer to SM1 for serial port mode selection. SMOD0 must be cleared to enable access to the SM0 bit.						
6	SM <sup>2</sup>	<u>SM0</u>	0 Sł 1 8- 0 9-	ode <u>E</u> hift Register F bit UART \ bit UART F	Baud Rate T <sub>XTAL</sub> /12 (or F <sub>X</sub> /ariable T <sub>XTAL</sub> /64 or F <sub>XT</sub> /ariable		• X2)		
5	SM2	2 Clear Set to	Serial port Mode 2 bit / Multiprocessor Communication Enable bit Clear to disable multiprocessor communication feature. Set to enable multiprocessor communication feature in mode 2 and 3, and eventually mode 1. This bit should be cleared in mode 0.						
4	REN	Clear	otion Enable to disable seri enable serial	ial reception.					
3	TB8	Clear	to transmit a l	<b>Ninth bit to tr</b> ogic 0 in the 9 jic 1 in the 9th		odes 2 and 3			
2	RB8	Cleare Set by	Receiver Bit 8 / Ninth bit received in modes 2 and 3 Cleared by hardware if 9th bit received is a logic 0. Set by hardware if 9th bit received is a logic 1. In mode 1, if SM2 = 0, RB8 is the received stop bit. In mode 0 RB8 is not						
1	ті	Clear Set by	<b>Transmit Interrupt flag</b> Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0 or at the beginning of the stop bit in the other modes.						
0	RI	Clear Set by		ge interrupt.	8th bit time in	mode 0, see	Figure 18.		

Reset Value = 0000 0000b Bit addressable





Baud Rates	F <sub>osc</sub> = 16	. 384 MHz	F <sub>osc</sub> = 24MHz		
	BRL	Error (%)	BRL	Error (%)	
115200	247	1.23	243	0.16	
57600	238	1.23	230	0.16	
38400	229	1.23	217	0.16	
28800	220	1.23	204	0.16	
19200	203	0.63	178	0.16	
9600	149	0.31	100	0.16	
4800	43	1.23	-	-	

 Table 34.
 Example of Computed Value When X2=1, SMOD1=1, SPD=1

 Table 35.
 Example of Computed Value When X2=0, SMOD1=0, SPD=0

Baud Rates	F <sub>osc</sub> = 16	. 384 MHz	F <sub>OSC</sub> = 24MHz		
	BRL	Error (%)	BRL	Error (%)	
4800	247	1.23	243	0.16	
2400	238	1.23	230	0.16	
1200	220	1.23	202	3.55	
600	185	0.16	152	0.16	

The baud rate generator can be used for mode 1 or 3 (refer to Figure 20.), but also for mode 0 for UART, thanks to the bit SRC located in BDRCON register (Table 42.)

#### **UART Registers**

#### Table 36. SADEN Register

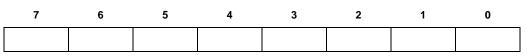
SADEN - Slave Address Mask Register for UART (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b

#### Table 37. SADDR Register

SADDR - Slave Address Register for UART (A9h)



Reset Value = 0000 0000b

#### Table 38. SBUF Register

SBUF - Serial Buffer Register for UART (99h)

7	6	5	4	3	2	1	0

Reset Value = XXXX XXXXb

#### Table 39. BRL Register

BRL - Baud Rate Reload Register for the internal baud rate generator, UART (9Ah)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b





### Table 40. T2CON Register

T2CON - Timer 2 Control Register (C8h)

7	6	5	4	3	2	1	0				
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#				
Bit Number	Bit Mnemonic		Description								
7	TF2	Must be clea	Fimer 2 overflow Flag Just be cleared by software. Set by hardware on timer 2 overflow, if RCLK = 0 and TCLK = 0.								
6	EXF2	Set when a EXEN2=1. When set, c interrupt is e Must be clea	<b>Timer 2 External Flag</b> Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. When set, causes the CPU to vector to timer 2 interrupt routine when timer 2 interrupt is enabled. Must be cleared by software. EXF2 doesn't cause an interrupt in Up/down counter mode (DCEN = 1)								
5	RCLK	Cleared to u	Receive Clock bit for UART Cleared to use timer 1 overflow as receive clock for serial port in mode 1 or 3. Set to use timer 2 overflow as receive clock for serial port in mode 1 or 3.								
4	TCLK	Cleared to u		IART rerflow as trans w as transmit							
3	EXEN2	Cleared to ig Set to cause	e a capture or	e bit on T2EX pin fo reload when a used to clock	a negative trar	sition on T2E	X pin is				
2	TR2		n control bit urn off timer 2 on timer 2.								
1	C/T2#	Cleared for	ter operation	<b>bit</b> on (input from i (input from T2							
0	CP/RL2#	If RCLK=1 of timer 2 over Cleared to a if EXEN2=1	flow. luto-reload or	l <b>bit</b> P/RL2# is igno n timer 2 overfl re transitions o	ows or negativ	ve transitions					

Reset Value = 0000 0000b Bit addressable

#### Table 41. PCON Register

PCON - Power Control Register (87h)

7	6	5	4	3	2	1	0			
SMOD1	SMOD0	-	- POF GF1 GF0 PD IDL							
Bit Number	Bit Mnemonic		Description							
7	SMOD1		<b>Mode bit 1 fc</b> t double baud	or UART I rate in mode	1, 2 or 3.					
6	SMOD0	Cleared to s	erial port Mode bit 0 for UART Cleared to select SM0 bit in SCON register. Set to select FE bit in SCON register.							
5	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	POF		ecognize next ware when VC		) to its nomina	l voltage. Car	n also be set			
3	GF1		user for gener	al purpose usa Irpose usage.	age.					
2	GF0			al purpose usa Irpose usage.	age.					
1	PD	Cleared by I	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.							
0	IDL	Idle mode I Cleared by I Set to enter	hardware whe	n interrupt or	eset occurs.					

Reset Value = 00X1 0000b Not bit addressable

Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.





### Table 42. BDRCON Register

BDRCON - Baud Rate Control Register (9Bh)

7	6	5	4	3	2	1	0					
-	-	-	BRR	ТВСК	RBCK	SPD	SRC					
Bit Number	Bit Mnemonic	Descriptior	Description									
7	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit									
6	-	Reserved The value re	ead from this	bit is indeterm	inate. Do not s	set this bit						
5	-	Reserved The value re	ead from this l	bit is indetermi	nate. Do not s	et this bit.						
4	BRR	Cleared to s	Baud Rate Run Control bit Cleared to stop the internal Baud Rate Generator. Set to start the internal Baud Rate Generator.									
3	ТВСК	Cleared to s	elect Timer 1	e Generator S or Timer 2 for d Rate Genera	the Baud Rate							
2	RBCK	Cleared to s	elect Timer 1	enerator Sele or Timer 2 for d Rate Genera	the Baud Rate							
1	SPD	Cleared to s	Baud Rate Speed Control bit for UART Cleared to select the SLOW Baud Rate Generator. Set to select the FAST Baud Rate Generator.									
0	SRC	Cleared to s mode).	elect F <sub>OSC</sub> /12	<b>ct bit in Mode</b> as the Baud F Baud Rate Ge	Rate Generato							

Reset Value = XXX0 0000b Not bit addressablef

### Interrupt System

The <u>AT89C51RB2/RC2</u> has a total of 9 interrupt vectors: two external interrupts (INT0 and INT1), three timer interrupts (timers 0, 1 and 2), the serial port interrupt, SPI interrupt, Keyboard interrupt and the PCA global interrupt. These interrupts are shown in Figure 22.

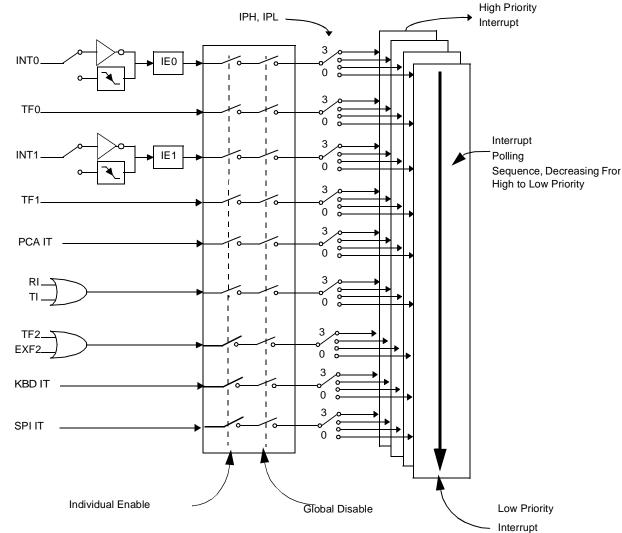


Figure 22. Interrupt Control System

Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register (Table 45 and Table 47). This register also contains a global disable bit, which must be cleared to disable all interrupts at once.

Each interrupt source can also be individually programmed to one out of four priority levels by setting or clearing a bit in the Interrupt Priority register (Table 48) and in the Interrupt Priority High register (Table 46 and Table 47) shows the bit values and priority levels associated with each combination.





### Registers

A low-priority interrupt can be interrupted by a high-priority interrupt, but not by another low-priority interrupt. A high-priority interrupt can't be interrupted by any other interrupt source.

#### Table 43. Priority Level Bit Values

IPH. x	IPL. x	Interrupt Level Priority		
0	0	0 (Lowest)		
0	1	1		
1	0	2		
1	1	3 (Highest)		

If two interrupt requests of different priority levels are received simultaneously, the request of higher-priority level is serviced. If interrupt requests of the same priority level are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

### Table 44. IENO Register

IEN0 - Interrupt Enable Register (A8h)

7	6	5	4	3	2	1	0				
EA	EC	ET2	ET2 ES ET1 EX1 ET0 EX0								
Bit Number	Bit Mnemonic	Description	escription								
7	EA	Cleared to d	inable All Interrupt Bit Cleared to disable all interrupts. Set to enable all interrupts.								
6	EC		CA Interrupt Enable Bit eared to disable. et to enable.								
5	ET2	Cleared to d	<b>Timer 2 Overflow Interrupt Enable Bit</b> Cleared to disable timer 2 overflow interrupt. Set to enable timer 2 overflow interrupt.								
4	ES		Enable Bit isable serial p e serial port in	•							
3	ET1	Cleared to d	isable timer 1	pt Enable Bit overflow inter flow interrupt.							
2	EX1	Cleared to d	errupt 1 Enal isable externa e external inte	al interrupt 1.							
1	ET0	Cleared to d	Fimer 0 Overflow Interrupt Enable Bit Cleared to disable timer 0 overflow interrupt. Set to enable timer 0 overflow interrupt.								
0	EX0	Cleared to d	errupt 0 Enal isable externa e external inte	al interrupt 0.							

Reset Value = 0000 0000b Bit addressable





### Table 45. IPL0 Register

IPL0 - Interrupt Priority Register (B8h)

7	6	5	4	3	2	1	0				
-	PPCL	PT2L	PT2L PSL PT1L PX1L PT0L PX0L								
Bit Number	Bit Mnemonic	Description	Description								
7	-	Reserved The value re	eserved ne value read from this bit is indeterminate. Do not set this bit.								
6	PPCL		<b>pt Priority B</b> or priority leve								
5	PT2L		Timer 2 Overflow Interrupt Priority Bit see PT2H for priority level.								
4	PSL	Serial Port I see PSH for	Priority Bit priority level.								
3	PT1L		rflow Interru	ipt Priority Bi	t						
2	PX1L		errupt 1 Prio r priority leve								
1	PTOL		Fimer 0 Overflow Interrupt Priority Bit see PT0H for priority level.								
0	PX0L		<b>errupt 0 Prio</b> r priority leve								

Reset Value = X000 0000b Bit addressable

#### Table 46. IPH0 Register

IPH0 - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0				
-	PPCH	PT2H	PSH	PT1H	PX1H	PT0H	PX0H				
Bit Number	Bit Mnemonic	Description									
7	-	<b>Reserved</b> The value re	eserved ne value read from this bit is indeterminate. Do not set this bit.								
6	РРСН	PCA Interru           PPCHPPCL           0         0           0         1           1         0           1         1	<b>pt Priority Hi</b> <u>Priority Lev</u> Lowest Highest								
5	PT2H	Timer 2 Ove           PT2HPT2L           0         0           0         1           1         0           1         1	rflow Interru <u>Priority Lev</u> Lowest Highest	pt Priority Hi <u>/el</u>	gh Bit						
4	PSH	Serial Port I           PSH         PSL           0         0           0         1           1         0           1         1	Priority High <u>Priority Lev</u> Lowest Highest								
3	PT1H	Timer 1 Ove           PT1HPT1L           0         0           0         1           1         0           1         1	e <b>rflow Interru</b> <u>Priority Lev</u> Lowest Highest	pt Priority Hi <u>/el</u>	gh Bit						
2	PX1H	External Internation Internation Internation International International International International International Internation International I	errupt 1 Prior Priority Lev Lowest Highest								
1	РТОН	Timer 0 Ove           PT0HPT0L           0         0           0         1           1         0           1         1	rflow Interru <u>Priority Lev</u> Lowest Highest	pt Priority Hi <u>/el</u>	gh Bit						
0	РХОН	External Internation           PX0H PX0L           0         0           0         1           1         0           1         1	errupt 0 Prio Priority Lev Lowest Highest								

Reset Value = X000 0000b

Not bit addressable





### Table 47. IEN1 Register

IEN1 - Interrupt Enable Register (B1h)

7	6	5	4	3	2	1	0				
-	-	-	-	-	ESPI	-	KBD				
Bit Number	Bit Mnemonic	Description	Description								
7	-	Reserved									
6	-	Reserved									
5	-	Reserved									
4	-	Reserved									
3	-	Reserved									
2	ESPI	Cleared to di	t Enable Bit isable SPI inte e SPI interrup								
1	-	Reserved									
0	KBD	Cleared to di	<b>iterrupt Enab</b> isable keyboa e keyboard int	rd interrupt.							

Reset Value = XXXX X000b Bit addressable

### Table 48. IPL1 Register

IPL1 - Interrupt Priority Register (B2h)

7	6	5	4	3	2	1	0			
-	-	-	-	-	SPIL	-	KBDL			
Bit Number	Bit Mnemonic	Description								
7	-	Reserved The value rea	eserved ne value read from this bit is indeterminate. Do not set this bit.							
6	-	Reserved The value rea	ad from this b	oit is indetermi	nate. Do not s	et this bit.				
5	-	<b>Reserved</b> The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	-	<b>Reserved</b> The value rea	ad from this b	oit is indetermi	nate. Do not s	et this bit.				
3	-	<b>Reserved</b> The value rea	ad from this b	oit is indetermi	nate. Do not s	et this bit.				
2	SPIL		t Priority Bit priority level.							
1	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
0	KBDL	-	terrupt Prior r priority leve	-						

Reset Value = XXXX X000b Bit addressable





#### Table 49. IPH1 Register

IPH1 - Interrupt Priority High Register (B3h)

7	6	5	4	3	2	1	0
-	-	-	-	-	SPIH	-	KBDH
Bit Number	Bit Mnemonic	Description	Description				
7	-	<b>Reserved</b> The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.				
6	-	<b>Reserved</b> The value re	ad from this b	oit is indetermi	nate. Do not se	et this bit.	
5	-	<b>Reserved</b> The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.				
4	-	<b>Reserved</b> The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.				
3	-	Reserved The value read from this bit is indeterminate. Do not set this bit.					
2	SPIH	SPI Interrupt Priority High BitSPIHSPILPriority Level00Lowest01110111Highest					
1	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.					
0	KBDH	Keyboard Interrupt Priority High BitKB DHKBDLPriority Level00Lowest011011Highest					

Reset Value = XXXX X000b Not bit addressable

# Interrupt Sources and Vector Addresses

### Table 50. Interrupt Sources and Vector Addresses

Number	Polling Priority	Interrupt Source	Interrupt Request	Vector Address
0	0	Reset		0000h
1	1	INT0	IE0	0003h
2	2	Timer 0	TF0	000Bh
3	3	INT1	IE1	0013h
4	4	Timer 1	IF1	001Bh
5	6	UART	RI+TI	0023h
6	7	Timer 2	TF2+EXF2	002Bh
7	5	PCA	CF + CCFn (n = 0-4)	0033h
8	8	Keyboard	KBDIT	003Bh
9	9	SPI	SPIIT	004Bh



# AMEL

### **Keyboard Interface**

The AT89C51RB2/RC2 implements a keyboard interface allowing the connection of a 8 x n matrix keyboard. It is based on 8 inputs with programmable interrupt capability on both high or low level. These inputs are available as alternate function of P1 and allow to exit from idle and power-down modes.

The keyboard interfaces with the C51 core through 3 special function registers: KBLS, the Keyboard Level Selection register (Table 53), KBE, the Keyboard interrupt Enable register (Table 52), and KBF, the Keyboard Flag register (Table 51).

Interrupt The keyboard inputs are considered as 8 independent interrupt sources sharing the same interrupt vector. An interrupt enable bit (KBD in IEN1) allows global enable or disable of the keyboard interrupt (see Figure 23). As detailed in Figure 24 each keyboard input has the capability to detect a programmable level according to KBLS. x bit value. Level detection is then reported in interrupt flags KBF. x that can be masked by software using KBE. x bits.

This structure allows keyboard arrangement from 1 by n to 8 by n matrix and allow usage of P1 inputs for other purpose.



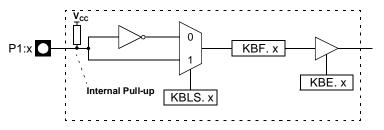
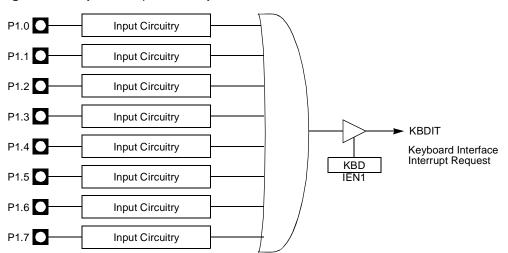


Figure 24. Keyboard Input Circuitry



#### **Power Reduction Mode**

P1 inputs allow exit from idle and power down modes as detailed in Section "Powerdown Mode", page 82.

### Registers

#### Table 51. KBF Register

KBF - Keyboard Flag Register (9Eh)

7	6	5	4	3	2	1	0	
KBF7	KBF6	KBF5	KBF4	KBF3	KBF2	KBF1	KBF0	
Bit Number	Bit Mnemonic	Description	Description					
7	KBF7	Set by hardw Keyboard int	<b>Keyboard Line 7 Flag</b> Set by hardware when the Port line 7 detects a programmed level. It generates a Keyboard interrupt request if the KBKBIE. 7 bit in KBIE register is set. Must be cleared by software.					
6	KBF6	Set by hardw Keyboard int	Keyboard Line 6 Flag Set by hardware when the Port line 6 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 6 bit in KBIE register is set. Must be cleared by software.					
5	KBF5	<b>Keyboard Line 5 Flag</b> Set by hardware when the Port line 5 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 5 bit in KBIE register is set. Must be cleared by software.						
4	KBF4	<b>Keyboard Line 4 Flag</b> Set by hardware when the Port line 4 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 4 bit in KBIE register is set. Must be cleared by software.						
3	KBF3	<b>Keyboard Line 3 Flag</b> Set by hardware when the Port line 3 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 3 bit in KBIE register is set. Must be cleared by software.						
2	KBF2	<b>Keyboard Line 2 Flag</b> Set by hardware when the Port line 2 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 2 bit in KBIE register is set. Must be cleared by software.						
1	KBF1	<b>Keyboard Line 1 Flag</b> Set by hardware when the Port line 1 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 1 bit in KBIE register is set. Must be cleared by software.						
0	KBF0	<b>Keyboard Line 0 Flag</b> Set by hardware when the Port line 0 detects a programmed level. It generates a Keyboard interrupt request if the KBIE. 0 bit in KBIE register is set. Must be cleared by software.						

Reset Value = 0000 0000b

This register is read only access, all flags are automatically cleared by reading the register.





### Table 52. KBE Register

KBE - Keyboard Input Enable Register (9Dh)

7	6	5	4	3	2	1	0	
KBE7	KBE6	KBE5	KBE4	KBE3	KBE2	KBE1	KBE0	
Bit Number	Bit Mnemonic	Description						
7	KBE7	Cleared to en	<b>Keyboard Line 7 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 7 bit in KBF register to generate an interrupt request.					
6	KBE6	Cleared to en	i <b>ne 6 Enable</b> nable standar e KBF. 6 bit in		to generate ar	n interrupt req	uest.	
5	KBE5	Cleared to en	<b>Keyboard Line 5 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 5 bit in KBF register to generate an interrupt request.					
4	KBE4	<b>Keyboard Line 4 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 4 bit in KBF register to generate an interrupt request.						
3	KBE3	<b>Keyboard Line 3 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 3 bit in KBF register to generate an interrupt request.						
2	KBE2	<b>Keyboard Line 2 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 2 bit in KBF register to generate an interrupt request.						
1	KBE1	<b>Keyboard Line 1 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 1 bit in KBF register to generate an interrupt request.						
0	KBE0	<b>Keyboard Line 0 Enable Bit</b> Cleared to enable standard I/O pin. Set to enable KBF. 0 bit in KBF register to generate an interrupt request.						

Reset Value = 0000 0000b

### Table 53. KBLS Register

KBLS - Keyboard Level Selector Register (9Ch)

7	6	5	4	3	2	1	0	
KBLS7	KBLS6	KBLS5	KBLS4	KBLS3	KBLS2	KBLS1	KBLS0	
Bit Number	Bit Mnemonic	Description	Description					
7	KBLS7	Cleared to en	Keyboard Line 7 Level Selection Bit Cleared to enable a low level detection on Port line 7. Set to enable a high level detection on Port line 7.					
6	KBLS6	Cleared to en	<b>Keyboard Line 6 Level Selection Bit</b> Cleared to enable a low level detection on Port line 6. Set to enable a high level detection on Port line 6.					
5	KBLS5	<b>Keyboard Line 5 Level Selection Bit</b> Cleared to enable a low level detection on Port line 5. Set to enable a high level detection on Port line 5.						
4	KBLS4	<b>Keyboard Line 4 Level Selection Bit</b> Cleared to enable a low level detection on Port line 4. Set to enable a high level detection on Port line 4.						
3	KBLS3	Keyboard Line 3 Level Selection Bit Cleared to enable a low level detection on Port line 3. Set to enable a high level detection on Port line 3.						
2	KBLS2	Keyboard Line 2 Level Selection Bit Cleared to enable a low level detection on Port line 2. Set to enable a high level detection on Port line 2.						
1	KBLS1	<b>Keyboard Line 1 Level Selection Bit</b> Cleared to enable a low level detection on Port line 1. Set to enable a high level detection on Port line 1.						
0	KBLS0	<b>Keyboard Line 0 Level Selection Bit</b> Cleared to enable a low level detection on Port line 0. Set to enable a high level detection on Port line 0.						

Reset Value = 0000 0000b



### Serial Port Interface The Serial Perip (SPI) The Serial Perip

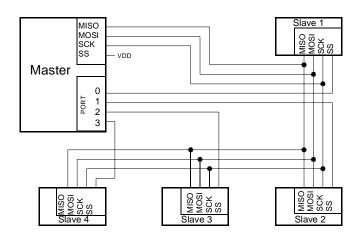
The Serial Peripheral Interface Module (SPI) allows full-duplex, synchronous, serial communication between the MCU and peripheral devices, including other MCUs.

### Features

- Features of the SPI Module include the following:
- Full-duplex, three-wire synchronous transfers
- Master or Slave operation
- Eight programmable Master clock rates
- Serial clock with programmable polarity and phase
- Master Mode fault error flag with MCU interrupt capability
- Write collision flag protection

Signal DescriptionFigure 25 shows a typical SPI bus configuration using one Master controller and many<br/>Slave peripherals. The bus is made of three wires connecting all the devices.

Figure 25. SPI Master/Slaves Interconnection



The Master device selects the individual Slave devices by using four pins of a parallel port to control the four  $\overline{SS}$  pins of the Slave devices.

Master Output Slave Input<br/>(MOSI)This 1-bit signal is directly connected between the Master Device and a Slave Device.<br/>The MOSI line is used to transfer data in series from the Master to the Slave. Therefore,<br/>it is an output signal from the Master, and an input signal to a Slave. A Byte (8-bit word)<br/>is transmitted most significant bit (MSB) first, least significant bit (LSB) last.

Master Input Slave Output<br/>(MISO)This 1-bit signal is directly connected between the Slave Device and a Master Device.<br/>The MISO line is used to transfer data in series from the Slave to the Master. Therefore,<br/>it is an output signal from the Slave, and an input signal to the Master. A Byte (8-bit<br/>word) is transmitted most significant bit (MSB) first, least significant bit (LSB) last.

**SPI Serial Clock (SCK)** This signal is used to synchronize the data movement both in and out of the devices through their MOSI and MISO lines. It is driven by the Master for eight clock cycles which allows to exchange one Byte on the serial lines.

Slave Select (SS)Each Slave peripheral is selected by one Slave Select pin (SS). This signal must stay<br/>low for any message for a Slave. It is obvious that only one Master (SS high level) can

	drive the network. The Master may select each Slave device by software through port pins (Figure 26). To prevent bus conflicts on the MISO line, only one slave should be selected at a time by the Master for a transmission.
	In a Master configuration, the $\overline{SS}$ line can be used in conjunction with the MODF flag in the SPI Status register (SPSTA) to prevent multiple masters from driving MOSI and SCK (see Error conditions).
	A high level on the $\overline{SS}$ pin puts the MISO line of a Slave SPI in a high-impedance state.
	The $\overline{\text{SS}}$ pin could be used as a general-purpose if the following conditions are met:
	• The device is configured as a Master and the SSDIS control bit in SPCON is set. This kind of configuration can be found when only one Master is driving the network and there is no way that the SS pin could be pulled low. Therefore, the MODF flag in the SPSTA will never be set <sup>(1)</sup> .
	• The Device is configured as a Slave with CPHA and SSDIS control bits set <sup>(2)</sup> . This kind of configuration can happen when the system comprises one Master and one Slave only. Therefore, the device should always be selected and there is no reason that the Master uses the SS pin to select the communicating Slave device.
	Note: 1. Clearing SSDIS control bit does not clear MODF.
	<ol> <li>Special care should be taken not to set SSDIS control bit when CPHA = '0' because in this mode, the SS is used to start the transmission.</li> </ol>
Baud Rate	In Master mode, the baud rate can be selected from a baud rate generator which is con- trolled by three bits in the SPCON register: SPR2, SPR1 and SPR0. The Master clock is selected from one of seven clock rates resulting from the division of the internal clock by 2, 4, 8, 16, 32, 64 or 128.
	Table 54 gives the different clock rates selected by SPR2:SPR1:SPR0.

SPR2	SPR1	SPR0	Clock Rate	Baud Rate Divisor (BD)
0	0	0	F <sub>CLK PERIPH</sub> /2	2
0	0	1	F <sub>CLK PERIPH</sub> /4	4
0	1	0	F <sub>CLK PERIPH</sub> /8	8
0	1	1	F <sub>CLK PERIPH</sub> /16	16
1	0	0	F <sub>CLK PERIPH</sub> /32	32
1	0	1	F <sub>CLK PERIPH</sub> /64	64
1	1	0	F <sub>CLK PERIPH</sub> /128	128
1	1	1	Don't Use	No BRG

Table 54. SPI Master Baud Rate Selection

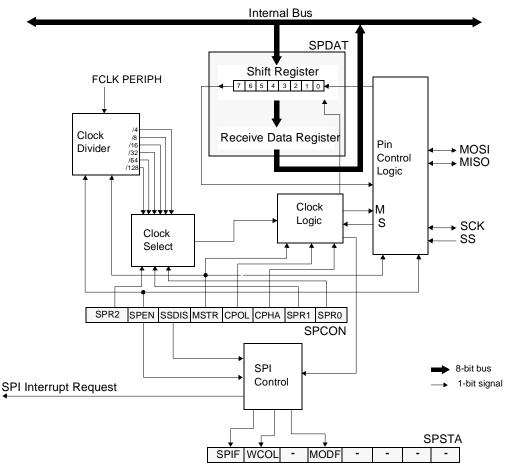




### **Functional Description**

Figure 26 shows a detailed structure of the SPI Module.

Figure 26. SPI Module Block Diagram



#### **Operating Modes**

The Serial Peripheral Interface can be configured in one of the two modes: Master mode or Slave mode. The configuration and initialization of the SPI Module is made through one register:

• The Serial Peripheral Control register (SPCON)

Once the SPI is configured, the data exchange is made using:

- SPCON
- The Serial Peripheral STAtus register (SPSTA)
- The Serial Peripheral DATa register (SPDAT)

During an SPI transmission, data is simultaneously transmitted (shifted out serially) and received (shifted in serially). A serial clock line (SCK) synchronizes shifting and sampling on the two serial data lines (MOSI and MISO). A Slave Select line ( $\overline{SS}$ ) allows individual selection of a Slave SPI device; Slave devices that are not selected do not interfere with SPI bus activities.

When the Master device transmits data to the Slave device via the MOSI line, the Slave device responds by sending data to the Master device via the MISO line. This implies full-duplex transmission with both data out and data in synchronized with the same clock (Figure 27).

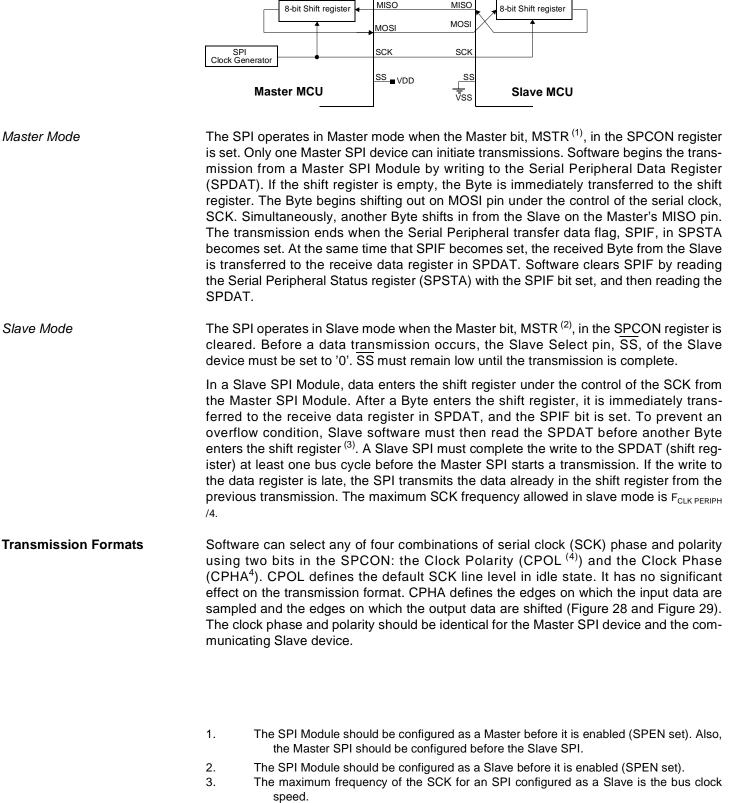
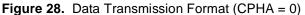


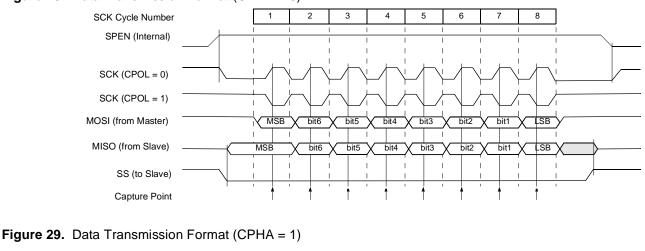
Figure 27. Full-Duplex Master-Slave Interconnection

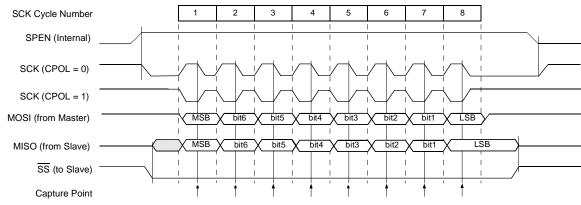
4. Before writing to the CPOL and CPHA bits, the SPI should be disabled (SPEN = '0').



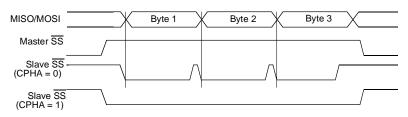












As shown in Figure 28, the first SCK edge is the MSB capture strobe. Therefore, the Slave must begin driving its data before the first SCK edge, and a falling edge on the  $\overline{SS}$  pin is used to start the transmission. The  $\overline{SS}$  pin must be toggled high and then low between each Byte transmitted (Figure 30).

Figure 29 shows an SPI transmission in which CPHA is '1'. In this case, the Master begins driving its MOSI pin on the first SCK edge. Therefore, the Slave uses the first SCK edge as a start transmission signal. The  $\overline{SS}$  pin can remain low between transmissions (Figure 30). This format may be preffered in systems having only one Master and only one Slave driving the MISO data line.

Error Conditions	The following flags in the SPSTA signal SPI error conditions:
Mode Fault (MODF)	<ul> <li>Mode Fault error in Master mode SPI indicates that the level on the Slave Select (SS) pin is inconsistent with the actual mode of the device. MODF is set to warn that there may be a multi-master conflict for system control. In this case, the SPI system is affected in the following ways:</li> <li>An SPI receiver/error CPU interrupt request is generated</li> <li>The SPEN bit in SPCON is cleared. This disables the SPI</li> <li>The MSTR bit in SPCON is cleared</li> </ul>
	When $\overline{SS}$ Disable (SSDIS) bit in the SPCON register is cleared, the MODF flag is set when the $\overline{SS}$ signal becomes '0'.
	However, as stated before, for a system with one Master, if the $\overline{SS}$ pin of the Master device is pulled low, there is no way that another Master attempts to drive the network. In this case, to prevent the MODF flag from being set, software can set the SSDIS bit in the SPCON register and therefore making the $\overline{SS}$ pin as a general-purpose I/O pin.
	Clearing the MODF bit is accomplished by a read of SPSTA register with MODF bit set, followed by a write to the SPCON register. SPEN Control bit may be restored to its original set state after the MODF bit has been cleared.
Write Collision (WCOL)	A Write Collision (WCOL) flag in the SPSTA is set when a write to the SPDAT register is done during a transmit sequence.
	WCOL does not cause an interruption, and the transfer continues uninterrupted.
	Clearing the WCOL bit is done through a software sequence of an access to SPSTA and an access to SPDAT.
Overrun Condition	An overrun condition occurs when the Master device tries to send several data Bytes and the Slave devise has not cleared the SPIF bit issuing from the previous data Byte transmitted. In this case, the receiver buffer contains the Byte sent after the SPIF bit was last cleared. A read of the SPDAT returns this Byte. All others Bytes are lost.
	This condition is not detected by the SPI peripheral.
SS Error Flag (SSERR)	A Synchronous Serial Slave Error occurs when $\overline{SS}$ goes high before the end of a received data in slave mode. SSERR does not cause in interruption, this bit is cleared by writing 0 to SPEN bit (reset of the SPI state machine).
Interrupts	Two SPI status flags can generate a CPU interrupt requests:
	Table 55. SPI Interrupts

Flag	Request
SPIF (SP data transfer)	SPI Transmitter Interrupt request
MODF (Mode Fault)	SPI Receiver/Error Interrupt Request (if SSDIS = '0')

Serial Peripheral data transfer flag, SPIF: This bit is set by hardware when a transfer has been completed. SPIF bit generates transmitter CPU interrupt requests.

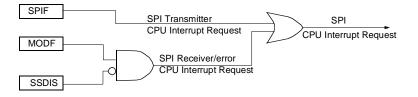
Mode Fault flag, MODF: This bit becomes set to indicate that the level on the SS is inconsistent with the mode of the SPI. MODF with SSDIS reset, generates receiver/error CPU interrupt requests. When SSDIS is set, no MODF interrupt request is generated.

Figure 31 gives a logical view of the above statements.





### Figure 31. SPI Interrupt Requests Generation



#### Registers

There are three registers in the Module that provide control, status and data storage functions. These registers are describes in the following paragraphs.

Serial Peripheral Control Register (SPCON)

- The Serial Peripheral Control Register does the following:
- Selects one of the Master clock rates
- Configure the SPI Module as Master or Slave
- Selects serial clock polarity and phase
- Enables the SPI Module
- Frees the SS pin for a general-purpose

Table 56 describes this register and explains the use of each bit

Table 56. SPCON Register

SPCON - Serial Peripheral Control Register (0C3H)

7	6	5	4	3	2	1	0
SPR2	SPEN	SSDIS	MSTR	CPOL	СРНА	SPR1	SPR0
Bit Number	Bit Mne	emonic	Description				
7	SF	PR2	Serial Peripheral Rate 2 Bit with SPR1 and SPR0 define the clock rate.				
6	SF	PEN	Serial Peripheral Enable Cleared to disable the SPI interface. Set to enable the SPI interface.				
5	ss	DIS	<b>SS</b> Disable Cleared to enable $\overline{SS}$ in both Master and Slave modes. Set to disable $\overline{SS}$ in both Master and Slave modes. In Slave m this bit has no effect if CPHA ='0'. When SSDIS is set, no MOI interrupt request is generated.				
4	MS	STR	Serial Peripheral Master Cleared to configure the SPI as a Slave. Set to configure the SPI as a Master.				
3	CF	POL	<b>Clock Polarity</b> Cleared to have the SCK set to '0' in idle state. Set to have the SCK set to '1' in idle low.				
2	CF	РНА	Clock Phase Cleared to have the data sampled when the SCK leaves the idle state (see CPOL). Set to have the data sampled when the SCK returns to idle state CPOL).				

Bit Number	Bit Mnemonic	Descri	Description			
		SPR2	SPR1	SPR0	Serial Peripheral Rate	
1	SPR1	0	0	0	F <sub>CLK PERIPH</sub> /2	
I		0	0	1	F <sub>CLK PERIPH</sub> /4	
		0	1	0	F <sub>CLK PERIPH</sub> /8	
		0	1	1	F <sub>CLK PERIPH</sub> /16	
		1	0	0	F <sub>CLK PERIPH</sub> /32	
0	SPR0	1	0	1	F <sub>CLK PERIPH</sub> /64	
-		1	1	0	F <sub>CLK PERIPH</sub> /128	
		1	1	1	Invalid	

Reset Value = 0001 0100b

Not bit addressable

Serial Peripheral Status Register The Serial Peripheral Status Register contains flags to signal the following conditions:

(SPSTA)

- Data transfer complete
- Write collision
- Inconsistent logic level on SS pin (mode fault error)

Table 57 describes the SPSTA register and explains the use of every bit in the register.

### Table 57. SPSTA Register

SPSTA - Serial Peripheral Status and Control register (0C4H)

7	6	5	4	3	2	1	0			
SPIF	WCOL	SSERR	MODF	-	-	-	-			
Bit Number	Bit Mnemonic	Description	Description							
7	SPIF	Cleared by ha	Serial Peripheral Data Transfer Flag Cleared by hardware to indicate data transfer is in progress or has been approved by a clearing sequence. Set by hardware to indicate that the data transfer has been completed.							
6	WCOL	Cleared by ha	Write Collision Flag Cleared by hardware to indicate that no collision has occurred or has been approved by a clearing sequence. Set by hardware to indicate that a collision has been detected.							
5	SSERR	-	are when $\overline{SS}$	is deasserted	before the en PEN bit in SP0		d data.			
4	MODF	has been app	<b>Mode Fault</b> Cleared by hardware to indicate that the $\overline{SS}$ pin is at appropriate logic level, or has been approved by a clearing sequence. Set by hardware to indicate that the $\overline{SS}$ pin is at inappropriate logic level.							
3	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit							
2	-	Reserved The value rea	ad from this bi	t is indetermir	nate. Do not se	et this bit.				





Bit Number	Bit Mnemonic	Description
1	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
0	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.

Reset Value = 00X0 XXXXb

Not Bit addressable

Serial Peripheral DATa Register (SPDAT) The Serial Peripheral Data Register (Table 58) is a read/write buffer for the receive data register. A write to SPDAT places data directly into the shift register. No transmit buffer is available in this model.

A Read of the SPDAT returns the value located in the receive buffer and not the content of the shift register.

### Table 58. SPDAT Register

SPDAT - Serial Peripheral Data Register (0C5H)

7	6	5	4	3	2	1	0
R7	R6	R5	R4	R3	R2	R1	R0

Reset Value = Indeterminate

R7:R0: Receive data bits

SPCON, SPSTA and SPDAT registers may be read and written at any time while there is no on-going exchange. However, special care should be taken when writing to them while a transmission is on-going:

- Do not change SPR2, SPR1 and SPR0
- Do not change CPHA and CPOL
- Do not change MSTR
- Clearing SPEN would immediately disable the peripheral
- Writing to the SPDAT will cause an overflow.

### Hardware Watchdog Timer

The WDT is intended as a recovery method in situations where the CPU may be subjected to software upset. The WDT consists of a 14-bit counter and the Watchdog Timer Reset (WDTRST) SFR. The WDT is by default disabled from exiting reset. To enable the WDT, user must write 01EH and 0E1H in sequence to the WDTRST, SFR location 0A6H. When WDT is enabled, it will increment every machine cycle while the oscillator is running and there is no way to disable the WDT except through reset (either hardware reset or WDT overflow reset). When WDT overflows, it will drive an output RESET HIGH pulse at the RST-pin.

**Using the WDT** To enable the WDT, user must write 01EH and 0E1H in sequence to the WDTRST, SFR location 0A6H. When WDT is enabled, the user needs to service it by writing to 01EH and 0E1H to WDTRST to avoid WDT overflow. The 14-bit counter overflows when it reaches 16383 (3FFFH) and this will reset the device. When WDT is enabled, it will increment every machine cycle while the oscillator is running. This means the user must write 01EH and 0E1H to WDTRST. WDTRST. WDTRST is a write only register. The WDT counter cannot be read or written. When WDT overflows, it will generate an output RESET pulse at the RST-pin. The RESET pulse duration is 96 x T<sub>CLK PERIPH</sub>, where T<sub>CLK PERIPH</sub> 1/F<sub>CLK</sub> PERIPH. To make the best use of the WDT, it should be serviced in those sections of code that will periodically be executed within the time required to prevent a WDT reset.

To have a more powerful WDT, a  $2^7$  counter has been added to extend the Time-out capability, ranking from 16 ms to 2 s @  $F_{OSCA}$  = 12 MHz. To manage this feature, see WDTPRG register description, Table 59.

 Table 59.
 WDTRST Register

WDTRST - Watchdog Reset Register (0A6h)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-

Reset Value = XXXX XXXXb

Write only, this SFR is used to reset/enable the WDT by writing 01EH then 0E1H in sequence.





#### Table 60. WDTPRG Register

WDTPRG - Watchdog Timer Out Register (0A7h)

7	6	5	4	3	2	1	0
-	-	-	-	-	S2	S1	S0
Bit Number	Bit Mnemonic	Description					
7	-						
6	-						
5	-	Reserved The value rea	ad from this bi	t is undetermi	ned. Do not try	/ to set this bit	
4	-						
3	-						
2	S2	WDT Time-o	ut Select Bit	2			
1	S1	WDT Time-o	ut Select Bit	1			
0	S0	WDT Time-o	ut Select Bit	0			
		S2         S1           0         0           0         1           0         1           1         0           1         1           1         1	$\begin{array}{c} 1(2^{15} - 1) \text{ m} \\ 0 (2^{16} - 1) \text{ r} \\ 1(2^{17} - 1) \text{ m} \\ 0(2^{18} - 1) \text{ m} \\ 1 (2^{19} - 1) \text{ r} \\ 0(2^{20} - 1) \text{ m} \end{array}$	achine cycles nachine cycles nachine cycles nachine cycles nachine cycles nachine cycles nachine cycles	, 16. 3 ms @ , 32.7 ms @ F s, 65. 5 ms @ , 131 ms @ F , 262 ms @ F s, 542 ms @ F , 1.05 s @ F <sub>O</sub> s, 2.09 s @ F <sub>O</sub>	$F_{OSCA} = 12 \text{ MH}$ $F_{OSCA} = 12 \text{ MH}$ OSCA = 12  MH OSCA = 12  MH $F_{OSCA} = 12 \text{ MH}$ SCA = 12  MHz	Iz IHz z z Iz

Reset Value = XXXX X000

# WDT During Power-down and Idle

In Power-down mode the oscillator stops, which means the WDT also stops. While in Power-down mode the user does not need to service the WDT. There are two methods of exiting Power-down mode: by a hardware reset or via a level activated external interrupt which is enabled prior to entering Power-down mode. When Power-down is exited with hardware reset, servicing the WDT should occur as it normally should whenever the AT89C51RB2/RC2 is reset. Exiting Power-down with an interrupt is significantly different. The interrupt is held low long enough for the oscillator to stabilize. When the interrupt is brought high, the interrupt is serviced. To prevent the WDT from resetting the device while the interrupt pin is held low, the WDT is not started until the interrupt is pulled high. It is suggested that the WDT be reset during the interrupt service routine.

To ensure that the WDT does not overflow within a few states of exiting of power-down, it is better to reset the WDT just before entering power-down.

In the Idle mode, the oscillator continues to run. To prevent the WDT from resetting the AT89C51RB2/RC2 while in Idle mode, the user should always set up a timer that will periodically exit Idle, service the WDT, and re-enter Idle mode.

### ONCE<sup>™</sup> Mode (ON Chip Emulation)

The ONCE mode facilitates testing and debugging of systems using AT89C51RB2/RC2 without removing the circuit from the board. The ONCE mode is invoked by driving certain pins of the AT89C51RB2/RC2; the following sequence must be exercised:

- Pull ALE low while the device is in reset (RST high) and PSEN is high.
- Hold ALE low as RST is deactivated.

While the AT89C51RB2/RC2 is in ONCE mode, an emulator or test CPU can be used to drive the circuit. Table 61 shows the status of the port pins during ONCE mode.

Normal operation is restored when normal reset is applied.

ALE	PSEN	Port 0	Port 1	Port 2	Port 3	XTAL1/2
Weak pull-up	Weak pull-up	Float	Weak pull-up	Weak pull-up	Weak pull-up	Active





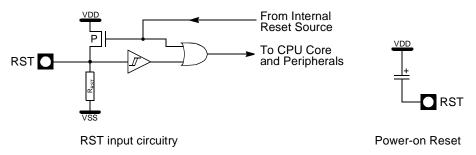
### **Power Management**

Two power reduction modes are implemented in the AT89C51RB2/RC2: the Idle mode and the Power-down mode. These modes are detailed in the following sections. In addition to these power reduction modes, the clocks of the core and peripherals can be dynamically divided by 2 using the X2 mode detailed in Section "X2 Feature".

Reset

In order to start-up (cold reset) or to restart (warm reset) properly the microcontroller, an high level has to be applied on the RST pin. A bad level leads to a wrong initialization of the internal registers like SFRs, Program Counter... and to unpredictable behavior of the microcontroller. A proper device reset initializes the AT89C51RB2/RC2 and vectors the CPU to address 0000h. RST input has a pull-down resistor allowing power-on reset by simply connecting an external capacitor to  $V_{DD}$  as shown in Figure 32. A warm reset can be applied either directly on the RST pin or indirectly by an internal reset source such as the watchdog timer. Resistor value and input characteristics are discussed in the Section "DC Characteristics" of the AT89C51RB2/RC2 datasheet.

Figure 32. Reset Circuitry and Power-On Reset



### **Cold Reset**

2 conditions are required before enabling a CPU start-up:

- V<sub>DD</sub> must reach the specified V<sub>DD</sub> range
- The level on X1 input pin must be outside the specification (V<sub>IH</sub>, V<sub>IL</sub>)

If one of these 2 conditions are not met, the microcontroller does not start correctly and can execute an instruction fetch from anywhere in the program space. An active level applied on the RST pin must be maintained till both of the above conditions are met. A reset is active when the level  $V_{IH1}$  is reached and when the pulse width covers the period of time where  $V_{DD}$  and the oscillator are not stabilized. 2 parameters have to be taken into account to determine the reset pulse width:

- V<sub>DD</sub> rise time,
- Oscillator startup time.

To determine the capacitor value to implement, the highest value of these 2 parameters has to be chosen. Table 1 gives some capacitor values examples for a minimum  $R_{RST}$  of 50 K $\Omega$  and different oscillator startup and  $V_{DD}$  rise times.

Oscillator		VDD Rise Time	
Start-Up Time	1 ms	10 ms	100 ms
5 ms	820 nF	1.2 µF	12 µF
20 ms	2.7 µF	3.9 µF	12 µF

Table 1. Minimum Reset Capacitor Value for a 50 k $\Omega$  Pull-down Resistor<sup>(1)</sup>

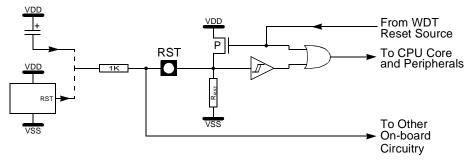
Note: These values assume V<sub>DD</sub> starts from 0V to the nominal value. If the time between 2 on/off sequences is too fast, the power-supply de-coupling capacitors may not be fully discharged, leading to a bad reset sequence.

#### Warm Reset

To achieve a valid reset, the reset signal must be maintained for at least 2 machine cycles (24 oscillator clock periods) while the oscillator is running. The number of clock periods is mode independent (X2 or X1).

Watchdog ResetAs detailed in Section "Hardware Watchdog Timer", page 77, the WDT generates a 96-<br/>clock period pulse on the RST pin. In order to properly propagate this pulse to the rest of<br/>the application in case of external capacitor or power-supply supervisor circuit, a 1 kΩ<br/>resistor must be added as shown Figure 33.

Figure 33. Reset Circuitry for WDT Reset-out Usage



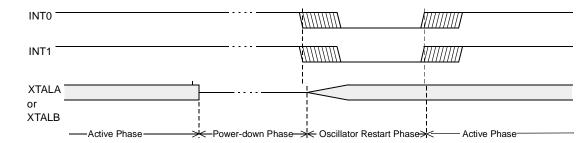


Α	MEL

Reset Recommendation to Prevent Flash Corruption	An example of bad initialization situation may occur in an instance where the bit ENBOOT in AUXR1 register is initialized from the hardware bit BLJB upon reset. Since this bit allows mapping of the bootloader in the code area, a reset failure can be critical.
•	If one wants the ENBOOT cleared in order to unmap the boot from the code area (yet due to a bad reset) the bit ENBOOT in SFRs may be set. If the value of Program Counter is accidently in the range of the boot memory addresses then a Flash access (write or erase) may corrupt the Flash on-chip memory.
	It is recommended to use an external reset circuitry featuring power supply monitoring to prevent system malfunction during periods of insufficient power supply voltage (power supply failure, power supply switched off).
Idle Mode	An instruction that sets PCON.0 indicates that it is the last instruction to be executed before going into Idle mode. In Idle mode, the internal clock signal is gated off to the CPU, but not to the interrupt, Timer, and Serial Port functions. The CPU status is pre- served in its entirety: the Stack Pointer, Program Counter, Program Status Word, Accumulator and all other registers maintain their data during idle. The port pins hold the logical states they had at the time Idle was activated. ALE and PSEN hold at logic high level.
	There are two ways to terminate the Idle mode. Activation of any enabled interrupt will cause PCON.0 to be cleared by hardware, terminating the Idle mode. The interrupt will be serviced, and following RETI the next instruction to be executed will be the one following the instruction that put the device into idle.
	The flag bits GF0 and GF1 can be used to give an indication if an interrupt occurred dur- ing normal operation or during idle. For example, an instruction that activates idle can also set one or both flag bits. When idle is terminated by an interrupt, the interrupt ser- vice routine can examine the flag bits.
	The other way of terminating the Idle mode is with a hardware reset. Since the clock oscillator is still running, the hardware reset needs to be held active for only two machine cycles (24 oscillator periods) to complete the reset.
Power-down Mode	To save maximum power, a Power-down mode can be invoked by software (see Table 14, PCON register).
	In Power-down mode, the oscillator is stopped and the instruction that invoked Power- down mode is the last instruction executed. The internal RAM and SFRs retain their value until the Power-down mode is terminated. $V_{CC}$ can be lowered to save further power. Either a hardware reset or an external interrupt can cause an exit from Power- down. To properly terminate Power-down, the reset or external interrupt should not be executed before $V_{CC}$ is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize.
	Only external interrupts INTO, INT1 and Keyboard Interrupts are useful to exit from Power-down. For that, interrupt must be enabled and configured as level or edge sensi- tive interrupt input. When Keyboard Interrupt occurs after a power down mode, 1024 clocks are necessary to exit to power down mode and enter in operating mode.
	Holding the pin low restarts the oscillator but bringing the pin high completes the exit as detailed in Figure 34. When both interrupts are enabled, the oscillator restarts as soon as one of the two inputs is held low and power down exit will be completed when the first input will be released. In this case, the higher priority interrupt service routine is executed. Once the interrupt is serviced, the next instruction to be executed after RETI will

be the one following the instruction that puts the AT89C51RB2/RC2 into Power-down mode.

#### Figure 34. Power-down Exit Waveform



Exit from Power-down by reset redefines all the SFRs, exit from Power-down by external interrupt does no affect the SFRs.

Exit from Power-down by either reset or external interrupt or keyboard interrupt does not affect the internal RAM content.

Note: If idle mode is activated with Power-down mode (IDL and PD bits set), the exit sequence is unchanged, when execution is vectored to interrupt, PD and IDL bits are cleared and idle mode is not entered.

Table 62 shows the state of ports during idle and power-down modes.

### Table 62. State of Ports

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Port Data <sup>(1)</sup>	Port Data	Port Data	Port Data
Idle	External	1	1	Floating	Port Data	Address	Port Data
Power Down	Internal	0	0	Port Data <sup>(1)</sup>	Port Data	Port Data	Port Data
Power Down	External	0	0	Floating	Port Data	Port Data	Port Data

Port 0 can force a 0 level. A "one" will leave port floating.





### **Power-off Flag**

The Power-off flag allows the user to distinguish between a "cold start" reset and a "warm start" reset.

A cold start reset is the one induced by  $V_{CC}$  switch-on. A warm start reset occurs while  $V_{CC}$  is still applied to the device and could be generated by an exit from Power-down.

The Power-off flag (POF) is located in PCON register (Table 63). POF is set by hardware when  $V_{CC}$  rises from 0 to its nominal voltage. The POF can be set or cleared by software allowing the user to determine the type of reset.

#### Table 63. PCON Register

PCON - Power Control Register (87h)

7	6	5	4	3	2	1	0	
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL	
Bit Number	Bit Mnemonic	Description						
7	SMOD1	Serial port M Set to select		rate in mode 1	l, 2 or 3.			
6	SMOD0	Cleared to se	Serial port Mode Bit 0 Cleared to select SM0 bit in SCON register. Set to select FE bit in SCON register.					
5	-	Reserved The value read from this bit is indeterminate. Do not set this bit.						
4	POF	<b>Power-off Flag</b> Cleared to recognize next reset type. Set by hardware when V <sub>CC</sub> rises from 0 to its nominal voltage. Can also be set by software.					lso be set by	
3	GF1	<b>General-purpose Flag</b> Cleared by user for general-purpose usage. Set by user for general-purpose usage.						
2	GF0	<b>General-purpose Flag</b> Cleared by user for general-purpose usage. Set by user for general-purpose usage.						
1	PD	Power-down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.						
0	IDL	Idle Mode B Cleared by h Set to enter i	ardware wher	n interrupt or re	eset occurs.			

Reset Value = 00X1 0000b Not bit addressable

### **Reduced EMI Mode**

The ALE signal is used to demultiplex address and data buses on port 0 when used with external program or data memory. Nevertheless, during internal code execution, ALE signal is still generated. In order to reduce EMI, ALE signal can be disabled by setting AO bit.

The AO bit is located in AUXR register at bit location 0.As soon as AO is set, ALE is no longer output but remains active during MOVX and MOVC instructions and external fetches. During ALE disabling, ALE pin is weakly pulled high.

#### Table 64. AUXR Register

AUXR - Auxiliary Register (8Eh)

7	6	5	4	3	2	1	0	
DPU	-	МО	-	XRS1	XRS0	EXTRAM	AO	
Bit Number	Bit Mnemonic	Description						
7	DPU	Cleared to ad	<b>Disable Weak Pull-up</b> Cleared to activate the permanent weak pull up when latch data is logic 1 Set to disactive the weak pull-up.					
6	-	Reserved The value rea	ad from this b	it is indetermir	nate. Do not s	et this bit.		
5	MO	Pulse LengthCleared to stretch MOVX control: the $\overline{RD}$ and the $\overline{WR}$ pulse length is 6 clockperiods (default).Set to stretch MOVX control: the $\overline{RD}$ and the $\overline{WR}$ pulse length is 30 clockperiods.						
4	-	Reserved The value rea	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.					
3	XRS1	XRAM Size						
2	XRS0	XRS1         XRS0         XRAM size           0         0         256 Bytes (default)           0         1         512 Bytes           1         0         768 Bytes           1         1         1024 Bytes						
1	EXTRAM	EXTRAM Bit Cleared to access internal XRAM using movx @ Ri @ DPTR. Set to access external memory. Programmed by hardware after Power-up regarding Hardware Security Byte (HSB), default setting, XRAM selected.					rity Byte	
0	AO		is emitted at ised). (default			scillator frequer ring a MOVX o		





Flash EEPROM Memory	The Flash memory increases EPROM and ROM functionality with in-circuit electrical erasure and programming. It contains 16K or 32K Bytes of program memory organized in 128 or 256 pages of 128 Bytes. This memory is both parallel and serial In-system Pro- grammable (ISP). ISP allows devices to alter their own program memory in the actual end product under software control. A default serial loader (bootloader) program allows ISP of the Flash. The programming does not require external dedicated programming voltage. The necessary high programming voltage is generated on-chip using the standard V <sub>CC</sub> pins of the microcontroller.
Features	<ul> <li>Flash EEPROM internal program memory.</li> <li>Boot vector allows user provided Flash loader code to reside anywhere in the Flash memory space. This configuration provides flexibility to the user.</li> <li>Default loader in Boot ROM allows programming via the serial port without the need of a user-provided loader.</li> <li>Up to 64K Byte external program memory if the internal program memory is disabled (EA = 0).</li> <li>Programming and erase voltage with standard 5V or 3V V<sub>CC</sub> supply.</li> <li>Read/Programming/Erase: <ul> <li>Byte-wise read without wait state</li> <li>Byte or page erase and programming (10 ms)</li> </ul> </li> <li>Typical programming time (32K Bytes) in 10 s</li> <li>Parallel programming with 87C51 compatible hardware interface to programmer</li> <li>Programmable security for the code in the Flash</li> <li>100K write cycles</li> <li>10 years data retention</li> </ul>
Flash Programming and Erasure	<ul> <li>The 16K or 32K Bytes Flash is programmed by Bytes or by pages of 128 Bytes. It is not necessary to erase a Byte or a page before programming. The programming of a Byte or a page includes a self erase before programming.</li> <li>There are three methods of programming the Flash memory: <ul> <li>First, the on-chip ISP bootloader may be invoked which will use low level routines to program the pages. The interface used for serial downloading of Flash is the UART.</li> <li>Second, the Flash may be programmed or erased in the end-user application by calling low-level routines through a common entry point in the Boot ROM.</li> <li>Third, the Flash may be programmed using the parallel method by using a conventional EPROM programmer. The parallel programming method used by these devices is similar to that used by EPROM 87C51 but it is not identical and the commercially available programmers need to have support for the AT89C51RB2/RC2. The bootloader and the Application Programming Interface (API) routines are located in the BOOT ROM.</li> </ul> </li> </ul>

### Flash Registers and Memory Map

The AT89C51RB2/RC2 Flash memory uses several registers for its management:

- Hardware registers can only be accessed through the parallel programming modes which are handled by the parallel programmer.
- Software registers are in a special page of the Flash memory which can be accessed through the API or with the parallel programming modes. This page, called "Extra Flash Memory", is not in the internal Flash program memory addressing space.

Hardware Register The only hardware register of the AT89C51RB2/RC2 is called Hardware Security Byte (HSB).

7	6	5	4	3	2	1	0		
X2	BLJB	-	-	XRAM	LB2	LB1	LB0		
Bit Number	Bit Mnemonic	Description	Description						
7	X2	<b>X2 Mode</b> Programmed ('0' value) to force X2 mode (6 clocks per instruction) after reset. Unprogrammed ('1' Value) to force X1 mode, Standard Mode, after reset (Default).							
6	BLJB	Boot Loader Jump Bit Unprogrammed ('1' value) to start the user's application on next reset at address 0000h. Programmed ('0' value) to start the boot loader at address F800h on next reset (Default).							
5	-	Reserved							
4	-	Reserved							
3	XRAM	XRAM Config Bit (only programmable by programmer tools) Programmed to inhibit XRAM after reset. Unprogrammed, this bit to valid XRAM after reset (Default).							
2-0	LB2-0	-	User Memory Lock Bits (only programmable by programmer tools) See Table 66.						

Table 65. Hardware Security Byte (HSB)

Boot Loader Jump Bit (BLJB)

One bit of the HSB, the BLJB bit, is used to force the boot address:

- When this bit is programmed ('1' value) the boot address is 0000h.
- When this bit is unprogrammed ('1' value) the boot address is F800h. By default, this bit is unprogrammed and the ISP is enabled.

### Flash Memory Lock Bits

The three lock bits provide different levels of protection for the on-chip code and data, when programmed as shown in Table 66.





Program Lock Bits				
Security Level	LB0	LB1	LB2	Protection Description
1	U	U	U	No program lock features enabled.
2	Ρ	U	U	MOVC instruction executed from external program memory is disabled from fetching code Bytes from internal memory, $\overline{EA}$ is sampled and latched on reset, and further parallel programming of the Flash is disabled. ISP and software programming with API are still allowed.
3	х	Р	U	Same as 2, also verify through parallel programming interface is disabled.
4	х	Х	Р	Same as 3, also external execution is disabled. (Default)

Note: U: unprogrammed or "one" level.

P: programmed or "zero" level.

X: don't care

WARNING: Security level '2' and '3' should only be programmed after Flash and code verification.

These security bits protect the code access through the parallel programming interface. They are set by default to level 4. The code access through the ISP is still possible and is controlled by the "software security bits" which are stored in the extra Flash memory accessed by the ISP firmware.

To load a new application with the parallel programmer, a chip erase must first be done. This will set the HSB in its inactive state and will erase the Flash memory. The part reference can always be read using Flash parallel programming modes.

The default value of the HSB provides parts ready to be programmed with ISP:

- BLJB: Programmed force ISP operation.
- X2: Unprogrammed to force X1 mode (Standard Mode).
- XRAM: Unprogrammed to valid XRAM
- LB2-0: Security level four to protect the code from a parallel access with maximum security.

**Software Registers** Several registers are used, in factory and by parallel programmers, to make copies of hardware registers contents. These values are used by Atmel ISP.

These registers are in the "Extra Flash Memory" part of the Flash memory. This block is also called "XAF" or eXtra Array Flash. They are accessed in the following ways:

- Commands issued by the parallel memory programmer.
- Commands issued by the ISP software.
- Calls of API issued by the application software.

Several software registers are described in Table 67.

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**Default Values** 

Mnemonic	Definition	Default value	Description
SBV	Software Boot Vector	FCh	
HSB	Hardware security Byte	101x 1011b	
BSB	Boot Status Byte	0FFh	
SSB	Software Security Byte	FFh	
	Copy of the Manufacturer Code	58h	ATMEL
	Copy of the Device ID #1: Family Code	D7h	C51 X2, Electrically Erasable
	Copy of the Device ID #2: memories	F7h	AT89C51RB2/RC2 32KB
	size and type	FBh	AT89C51RB2/RC2 16 KB
	Copy of the Device ID #3: name and revision	EFh	AT89C51RB2/RC2 32KB, Revision 0
		FFh	AT89C51RB2/RC2 16 KB, Revision 0

 Table 67.
 Default Values

After programming the part by ISP, the BSB must be cleared (00h) in order to allow the application to boot at 0000h.

The content of the Software Security Byte (SSB) is described in Table 67 and Table 69.

To assure code protection from a parallel access, the HSB must also be at the required level.

7	6	5	4	3	2	1	0
-	-	-	-	-	-	LB1	LB0
Bit Number	Bit Mnemonic	Description					
7	-	Reserved Do not clear t	his bit.				
6	-	Reserved Do not clear t	Reserved Do not clear this bit.				
5	-	Reserved Do not clear t	Reserved Do not clear this bit.				
4	-	Reserved Do not clear t	Reserved Do not clear this bit.				
3	-	Reserved Do not clear t	Reserved Do not clear this bit.				
2	-	Reserved Do not clear this bit.					
1-0	LB1-0	User Memor see Table 69	-				

#### Table 68. Software Security Byte

The two lock bits provide different levels of protection for the on-chip code and data, when programmed as shown in Table 69.





#### Table 69. Program Lock Bits of the SSB

Program	n Lock I	Bits	
Security level	LB0	LB1	Protection Description
1	U	U	No program lock features enabled.
2	Р	U	ISP programming of the Flash is disabled.
3	Х	Р	Same as 2, also verify through ISP programming interface is disabled.

Note: U: unprogrammed or "one" level.

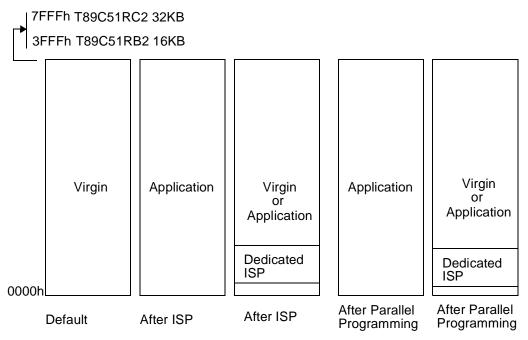
P: programmed or "zero" level.

X: don't care

WARNING: Security level 2 and 3 should only be programmed after Flash and code verification.

**Flash Memory Status** AT89C51RB2/RC2 parts are delivered in standard with the ISP boot in the Flash memory. After ISP or parallel programming, the possible contents of the Flash memory are summarized on Figure 35.

Figure 35. Flash Memory Possible Contents



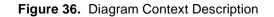
**Memory Organization** In the AT89C51RB2/RC2, the lowest 16K or 32K of the 64 KB program memory address space is filled by internal Flash.

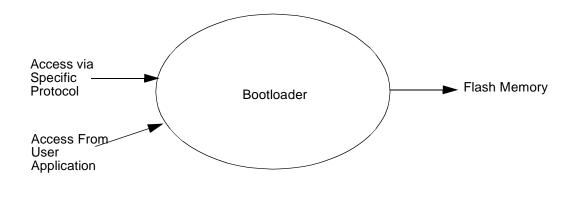
When the EA pin is high, the processor fetches instructions from internal program Flash. Bus expansion for accessing program memory from 16K or 32K upward automatic since external instruction fetches occur automatically when the program counter exceeds 3FFFh (16K) or 7FFFh (32K). If the EA pin is tied low, all program memory fetches are from external memory.

### **Bootloader Architecture**

Introduction

The bootloader manages a communication according to a specific defined protocol to provide the whole access and service on Flash memory. Furthermore, all accesses and routines can be called from the user application.





Acronyms

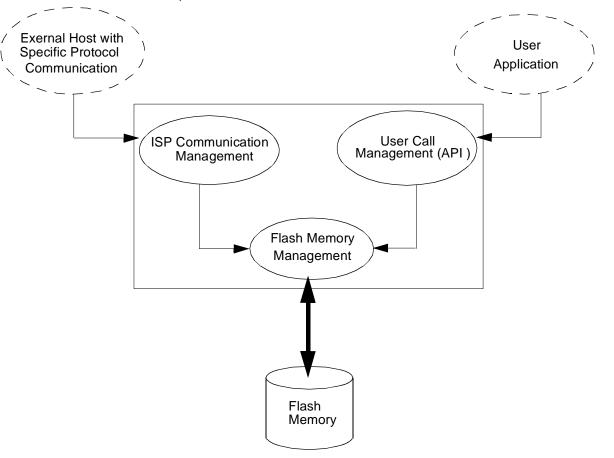
ISP: In-system Programming SBV: Software Boot Vector BSB: Boot Status Byte SSB: Software Security Bit HW : Hardware Byte





### **Functional Description**

Figure 37. Bootloader Functional Description



On the above diagram, the on-chip bootloader processes are:

ISP Communication Management

The purpose of this process is to manage the communication and its protocol between the on-chip bootloader and a external device. The on-chip ROM implement a serial protocol (see section Bootloader Protocol). This process translate serial communication frame (UART) into Flash memory acess (read, write, erase ...).

User Call Management

Several Application Program Interface (API) calls are available for use by an application program to permit selective erasing and programming of Flash pages. All calls are made through a common interface (API calls), included in the ROM bootloader. The programming functions are selected by setting up the microcontroller's registers before making a call to a common entry point (0xFFF0). Results are returned in the registers. The purpose on this process is to translate the registers values into internal Flash Memory Management.

Flash Memory Management

This process manages low level access to Flash memory (performs read and write access).

#### **Bootloader Functionality**

Introduction

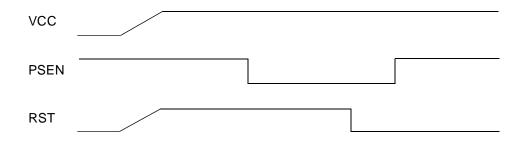
The bootloader can be activated by two means: Hardware conditions or regular boot process.

The Hardware conditions (EA = 1, PSEN = 0) during the Reset# falling edge force the on-chip bootloader execution. This allows an application to be built that will normally execute the end user's code but can be manually forced into default ISP operation.

As PSEN is an output port in normal operating mode (running user application or boorloader code) after reset, it is recommended to release PSEN after falling edge of reset signal. The hardware conditions are sampled at reset signal falling edge, thus they can be released at any time when reset input is low.

To ensure correct microcontroller startup, the PSEN pin should not be tied to ground during power-on (See Figure 38).

Figure 38. Hardware conditions typical sequence during power-on.



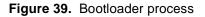
The on-chip bootloader boot process is shown in Figure 39.

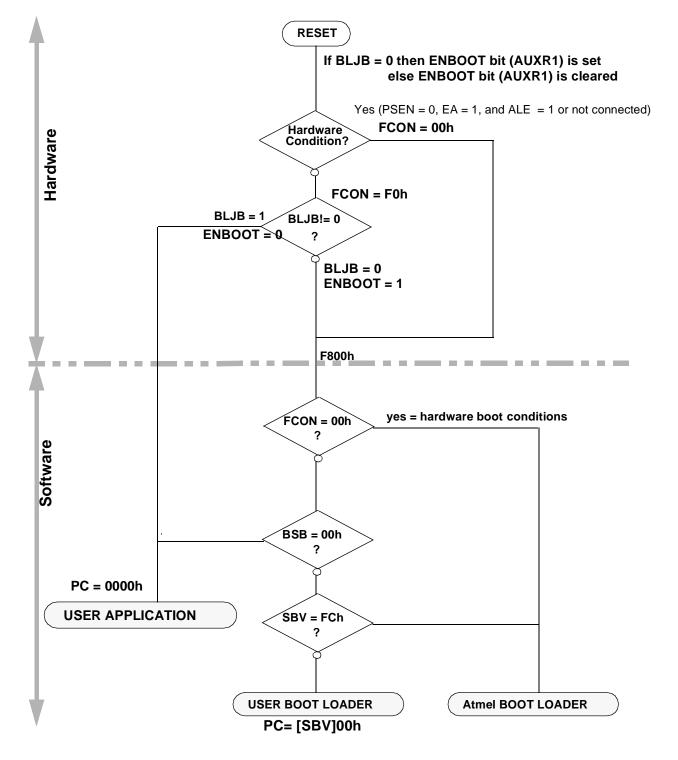
	Purpose
Hardware Conditions	The Hardware Conditions force the bootloader execution whatever BLJB, BSB and SBV values.
	The Boot Loader Jump Bit forces the application execution. BLJB = 0 => Boot loader execution. BLJB = 1 => Application execution.
BLJB	The BLJB is a fuse bit in the Hardware Byte.
	That can be modified by hardware (programmer) or by software (API).
	Note:
	The BLJB test is perform by hardware to prevent any program execution.
	The Software Boot Vector contains the high address of custumer bootloader stored in the application.
SBV	SBV = FCh (default value) if no custumer bootloader in user Flash.
	Note:
	The costumer bootloader is called by JMP [SBV]00h instruction.





#### **Boot Process**





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### **ISP Protocol Description**

### Physical Layer

The UART used to transmit information has the following configuration:

- Character: 8-bit data
- Parity: none
- Stop: 1 bit
- Flow control: none
- Baud rate: autobaud is performed by the bootloader to compute the baud rate choosen by the host.

### Frame DescriptionThe Serial Protocol is based on the Intel Hex-type records.

Intel Hex records consist of ASCII characters used to represent hexadecimal values and are summarized below.

### Table 70. Intel Hex Type Frame

Record Mark ':'	Reclen	Load Offset	Record Type	Data or Info	Checksum	
1 byte	1 byte	2 bytes	1 bytes	n byte	1 byte	

- Record Mark:
  - Record Mark is the start of frame. This field must contain ':'.
- Reclen:
  - Reclen specifies the number of Bytes of information or data which follows the Record Type field of the record.
- Load Offset:
  - Load Offset specifies the 16-bit starting load offset of the data Bytes, therefore this field is used only for
  - Data Program Record (see Section "ISP Commands Summary").
- Record Type:
  - Record Type specifies the command type. This field is used to interpret the remaining information within the frame. The encoding for all the current record types is described in Section "ISP Commands Summary".
- Data/Info:
  - Data/Info is a variable length field. It consists of zero or more Bytes encoded as pairs of hexadecimal digits. The meaning of data depends on the Record Type.
- Checksum:
  - The two's complement of the 8-bit Bytes that result from converting each pair of ASCII hexadecimal digits to one Byte of binary, and including the Reclen field to and including the last Byte of the Data/Info field. Therefore, the sum of all the ASCII pairs in a record after converting to binary, from the Reclen field to and including the Checksum field, is zero.





### **Functional Description**

**Software Security Bits (SSB)** The SSB protects any Flash access from ISP command. The command "Program Software Security bit" can only write a higher priority level.

There are three levels of security:

• level 0: NO\_SECURITY (FFh)

This is the default level. From level 0, one can write level 1 or level 2.

#### • level 1: WRITE\_SECURITY (FEh )

For this level it is impossible to write in the Flash memory, BSB and SBV. The Bootloader returns 'P' on write access. From level 1, one can write only level 2.

• level 2: RD\_WR\_SECURITY (FCh

The level 2 forbids all read and write accesses to/from the Flash/EEPROM memory. The Bootloader returns 'L' on read or write access.

Only a full chip erase in parallel mode (using a programmer) or ISP command can reset the software security bits.

From level 2, one cannot read and write anything.

	Level 0	Level 1	Level 2		
Flash/EEPROM	Any access allowed	Read only access allowed	Any access not allowed		
Fuse Bit	Any access allowed	Read only access allowed	Any access not allowed		
BSB & SBV	Any access allowed	Read only access allowed	Any access not allowed		
SSB	Any access allowed	Write level 2 allowed	Read only access allowed		
Manufacturer Info	Read only access allowed	Read only access allowed	Read only access allowed		
Bootloader Info	Read only access allowed	Read only access allowed	Read only access allowed		
Erase Block	Allowed	Not allowed	Not allowed		
Full-chip Erase	Allowed	Allowed	Allowed		
Blank Check	Allowed	Allowed	Allowed		

Table 71. Software Security Byte Behavior

Full Chip Erase	<ul> <li>The ISP command "Full Chip Erase" erases all User Flash memory (fills with FFh) and sets some Bytes used by the bootloader at their default values:</li> <li>BSB = FFh</li> <li>SBV = FCh</li> <li>SSB = FFh and finally erase the Software Security Bits</li> <li>The Full Chip Erase does not affect the bootloader.</li> </ul>						
Checksum Error	When a checksum error is detecte	d send 'X' followed with C	R&LF.				
Flow Description							
Overview	An initialization step must be perf the bootloader waits for an autoba						
	When the communication is init requested by the host.	tialized the protocol de	pends on the record type				
	FLIP, a software utility to impleme Atmel the web site.	ent ISP programming with	a PC, is available from the				
Communication Initialization	The host initializes the communica to compute the baudrate (autobau		acter to help the bootloader				
	Figure 40. Initialization						
	<u>Host</u>		<b>Bootloader</b>				
	Init Communication	"U"	Performs Autobaud				
	If (not received "U") Else Communication Opened	<b>≺</b> "U"	Sends Back 'U' Character				



# AIMEL

### Autobaud Performances

The ISP feature allows a wide range of baud rates in the user application. It is also adaptable to a wide range of oscillator frequencies. This is accomplished by measuring the bit-time of a single bit in a received character. This information is then used to program the baud rate in terms of timer counts based on the oscillator frequency. The ISP feature requires that an initial character (an uppercase U) be sent to the AT89C51RB2/RC2 to establish the baud rate. Table 72 shows the autobaud capability.

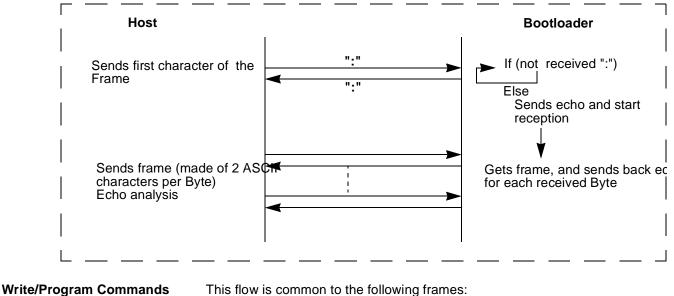
Frequency (MHz)										
Baudrate (bit/s)	1.8432	2	2.4576	3	3.6864	4	5	6	7.3728	8
2400	ОК	ОК	ОК	ок	ОК	ОК	ОК	ОК	ОК	ОК
4800	ОК	-	ок	ок	ок	ОК	ОК	ок	ок	OK
9600	ОК	-	ок	ок	ОК	ОК	ОК	ок	ок	OK
19200	ОК	-	ок	ОК	ОК	-	-	ок	ОК	OK
38400	-	-	ок		ок	-	ОК	ОК	ок	
57600	-	-	-	-	ОК	-	-	-	ОК	
115200	-	-	-	-	-	-	-	-	ОК	
								1		
Frequency (MHz)										
Baudrate (bit/s)	10	11.0592	12	14.318	14.746	16	20	24	26.6	
2400	ОК	ОК	ок	ок	ок	ок	ОК	ок	ок	
4800	ОК	ОК	ок	ок	ок	ОК	ОК	ок	ок	
9600	ОК	ОК	ОК	ОК	ОК	ОК	ОК	ОК	ОК	
19200	ОК	ОК	ОК	ОК	ОК	ОК	ОК	ок	ОК	
38400	-	ОК	ОК	ОК	ОК	ОК	OK	ОК	ок	
57600	-	ОК	-	ОК	ОК	ОК	OK	ОК	ОК	
115200	-	ОК	-	ОК	ОК	-	-	-	-	

### Table 72. Autobaud Performances

# Command Data Stream Protocol

All commands are sent using the same flow. Each frame sent by the host is echoed by the bootloader.

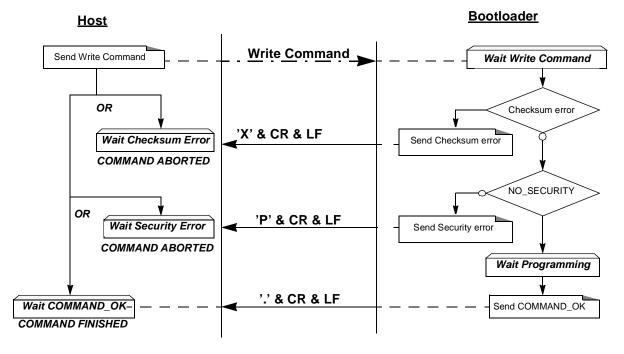
### Figure 41. Command Flow



- Flash/EEPROM Programming Data Frame
- EOF or Atmel Frame (only Programming Atmel Frame)
- Config Byte Programming Data Frame
- Baud Rate Frame

### Description









### Example

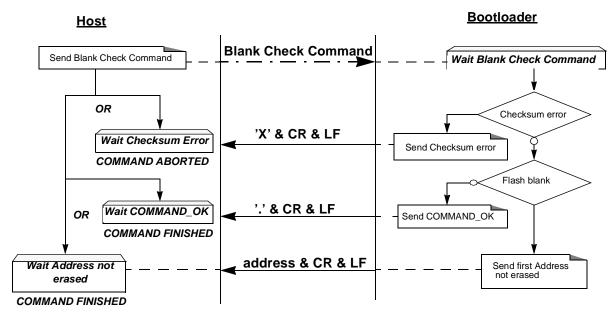
### Programming Data (write 55h at address 0010h in the Flash)

HOST	: 01	0010 00 55 9A
BOOTLOADER	: 01	0010 00 55 9A . CR LF
Programming	Atmel	function (write SSB to level 2)
HOST	: 02	0000 03 05 01 F5
BOOTLOADER	: 02	0000 03 05 01 F5. CR LF
Writing Fram	ne (wri	te BSB to 55h)
HOST	: 03	0000 03 06 00 55 9F
BOOTLOADER	: 03	0000 03 06 00 55 9F . CR LF

### **Blank Check Command**

#### Description

### Figure 43. Blank Check Flow



### Example

Blank	Check	ok												
HOST		:	05	0000	04	0000	7FFF	01	78					
BOOTL	OADER	:	05	0000	04	0000	7FFF	01	78	•	CR	LF		
Blank	Check	ko	at	addr	ess	xxx	x							
HOST		:	05	0000	04	0000	7FFF	01	78					
BOOTLO	DADER	:	05	0000	04	0000	7FFF	01	78	xx	xx	CR	LF	
Blank	Check	wi	th	check	sur	n err	or							
HOST		:	05	0000	04	0000	7FFF	01	70					
BOOTL	OADER	:	05	0000	04	0000	7FFF	01	70	Х	CR	LF	CR	$\mathbf{LF}$

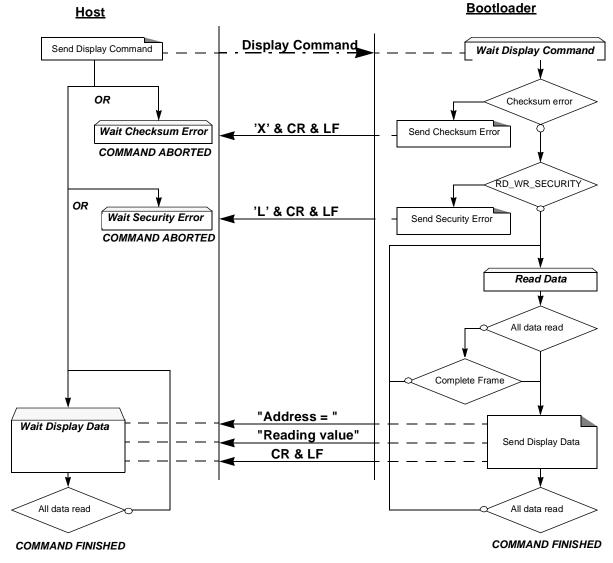




### **Display Data**

### Description

### Figure 44. Display Flow



Note: The maximum size of block is 400h. To read more than 400h Bytes, the Host must send a new command.

#### Example

Display	data	from	address	0000h	to	0020h

HOST	: 05 0000 04 0000 0020 00 D7	
BOOTLOADER	: 05 0000 04 0000 0020 00 D7	
BOOTLOADER	0000=data CR LF (	16 data)
BOOTLOADER	0010=data CR LF (	16 data)
BOOTLOADER	0020=data CR LF (	1 data)

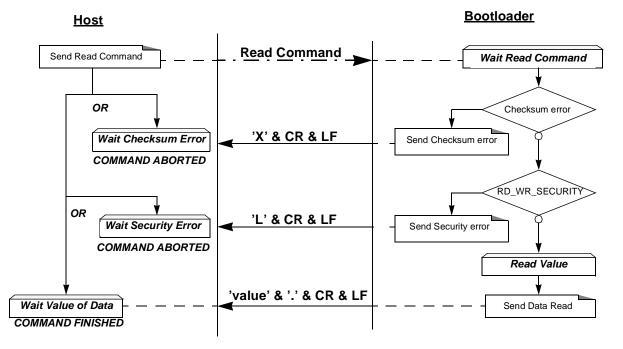
#### **Read Function**

This flow is similar for the following frames:

- Reading Frame
- EOF Frame/Atmel Frame (only reading Atmel Frame)

#### Description

Figure 45. Read Flow



#### Example

Read function (read SBV)											
HOST	:	02	0000	05	07	02	FO				
BOOTLOADER	:	02	0000	05	07	02	FO	Value	•	CR	LF
Atmel Read fu	nc	tic	on (r	ead	l Bo	oot	loa	der ve	er	sic	on)
HOST	:	02	0000	01	02	00	FB				
BOOTLOADER	:	02	0000	01	02	00	FB	Value		CR	$\mathbf{LF}$





### **ISP Commands Summary**

### Table 73. ISP Commands Summary

Command	Command Name	Data[0]	Data[1]	Command Effect
00h	Program Data			Program Nb Data Byte. Bootloader will accept up to 128 (80h) data Bytes. The data Bytes should be 128 Byte page Flash boundary.
			00h	Erase block0 (0000h-1FFFh)
			20h	Erase block1 (2000h-3FFFh)
		01h	40h	Erase block2 (4000h-7FFFh)
			80h	Erase block3 (8000h- BFFFh)
			C0h	Erase block4 (C000h- FFFFh)
		03h	00h	Hardware Reset
		04h	00h	Erase SBV & BSB
		05h	00h	Program SSB level 1
03h	Write Function	0011	01h	Program SSB level 2
		06h	00h	Program BSB (value to write in data[2])
		0011	01h	Program SBV (value to write in data[2])
		07h	-	Full Chip Erase (This command needs about 6 sec to be executed)
			02h	Program Osc fuse (value to write in data[2])
		0Ah	04h	Program BLJB fuse (value to write in data[2])
			08h	Program X2 fuse (value to write in data[2])
04h	Display Function	Data [2:3] = Data[4] = 00h	start address end address -> Display data -> Blank check	Display Data Note: The maximum number of data that can be read with a single command frame (difference between start and end address) is 1kbyte.
				Blank Check
			00h	Manufacturer ID
		00h	01h	Device ID #1
		0011	02h	Device ID #2
			03h	Device ID #3
			00h	Read SSB
05h	Read Function	07h	01h	Read BSB
05h	Reduir unotion	0/11	02h	Read SBV
			06h	Read Extra Byte
			00h	Read Hardware Byte
		0Eh	00h	Read Device Boot ID1
			01h	Read Device Boot ID2
		0Fh	00h	Read Bootloader Version

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### **API Call Description**

Several Application Program Interface (API) calls are available for use by an application program to permit selective erasing and programming of Flash pages. All calls are made through a common interface, PGM\_MTP. The programming functions are selected by setting up the microcontroller's registers before making a call to PGM\_MTP at FFF0h. Results are returned in the registers.

When several Bytes have to be programmed, it is highly recommended to use the Atmel API "PROGRAM DATA PAGE" call. Indeed, this API call writes up to 128 Bytes in a single command.

All routines for software access are provided in the C Flash driver available at Atmel's web site.

The API calls description and arguments are shown in Table 74.

#### Table 74. API Call Summary

Command	R1	Α	DPTR0	DPTR1	Returned Value	Command Effect
READ MANUF ID	00h	XXh	0000h	XXh	ACC = Manufacturer Id	Read Manufacturer identifier
READ DEVICE ID1	00h	XXh	0001h	XXh	ACC = Device Id 1	Read Device identifier 1
READ DEVICE ID2	00h	XXh	0002h	XXh	ACC = Device Id 2	Read Device identifier 2
READ DEVICE ID3	00h	XXh	0003h	XXh	ACC = Device Id 3	Read Device identifier 3
			DPH = 00h			Erase block 0
ERASE BLOCK	01h	XXh	DPH = 20h	00h	ACC = DPH	Erase block 1
			DPH = 40h			Erase block 2
PROGRAM DATA BYTE	02h	Vaue to write	Address of byte to program	XXh	ACC = 0: DONE	Program up one data byte in the on-chip flash memory.
			DPH = 00h DPL = 00h			Set SSB level 1
	0.5 h	XXh	DPH = 00h DPL = 01h	00h AC	ACC = SSB value	Set SSB level 2
PROGRAM SSB	05h	~~	DPH = 00h DPL = 10h		ACC = SSB value	Set SSB level 0
			DPH = 00h DPL = 11h			Set SSB level 1
PROGRAM BSB	06h	New BSB value	0000h	XXh	none	Program boot status byte
PROGRAM SBV	06h	New SBV value	0001h	XXh	none	Program software boot vector
READ SSB	07h	XXh	0000h	XXh	ACC = SSB	Read Software Security Byte
READ BSB	07h	XXh	0001h	XXh	ACC = BSB	Read Boot Status Byte
READ SBV	07h	XXh	0002h	XXh	ACC = SBV	Read Software Boot Vector
PROGRAM DATA PAGE	09h	Number of byte to program	Address of the first byte to program in the Flash memory	Address in XRAM of the first data to program	ACC = 0: DONE	Program up to 128 bytes in user Flash. Remark: number of bytes to program is limited such as the Flash write remains in a single 128 bytes page. Hence, when ACC is 128, valid values of DPL are 00h, or, 80h.





### Table 74. API Call Summary (Continued)

Command	R1	Α	DPTR0	DPTR1	Returned Value	Command Effect Program X2 fuse bit with ACC Program BLJB fuse bit with ACC		
PROGRAM X2 FUSE	0Ah	Fuse value 00h or 01h	0008h	XXh	none			
PROGRAM BLJB FUSE	0Ah	Fuse value 00h or 01h	0004h	XXh	none			
READ HSB	0Bh	XXh	XXXXh	XXh	ACC = HSB	Read Hardware Byte		
READ BOOT ID1	0Eh	XXh	DPL = 00h	XXh	ACC = ID1	Read boot ID1		
READ BOOT ID2	0Eh	XXh	DPL = 01h	XXh	ACC = ID2	Read boot ID2		
READ BOOT VERSION	0Fh	XXh	XXXXh	XXh	ACC = Boot_Version	Read bootloader version		

### **Electrical Characteristics**

### **Absolute Maximum Ratings**

$\label{eq:commercial} \begin{array}{lllllllllllllllllllllllllllllllllll$	Note:         Stresses at or above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and func- tional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Expo- sure to absolute maximum rating conditions may affect device reliability. Power dissipation value is based on the maximum allowable die temperature and the thermal resis- tance of the package.
---	--

# DC Parameters for Standard Voltage

 $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ ;  $V_{SS} = 0V$ ;

 $V_{CC}$  =2.7V to 5.5V and F = 0 to 40 MHz (both internal and external code execution)

 $V_{CC}$  =4.5V to 5.5V and F = 0 to 60 MHz (internal code execution only)

Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V <sub>IL</sub>	Input Low Voltage	-0.5		0.2 V <sub>CC</sub> - 0.1	V	
V <sub>IH</sub>	Input High Voltage except RST, XTAL1	0.2 V <sub>CC</sub> + 0.9		V <sub>CC</sub> + 0.5	V	
V <sub>IH1</sub> <sup>(9)</sup>	Input High Voltage RST, XTAL1	0.7 V <sub>CC</sub>		V <sub>CC</sub> + 0.5	V	
V <sub>OL</sub>	Output Low Voltage, ports 1, 2, 3, 4 <sup>(6)</sup>			0.3 0.45 1.0	V V V	$\begin{split} \text{VCC} &= 4.5 \text{V to } 5.5 \text{V} \\ \text{I}_{\text{OL}} &= 100 \; \mu \text{A}^{(4)} \\ \text{I}_{\text{OL}} &= 1.6 \; \text{m} \text{A}^{(4)} \\ \text{I}_{\text{OL}} &= 3.5 \; \text{m} \text{A}^{(4)} \end{split}$
				0.45	V	VCC = 2.7V to 5.5V $I_{OL} = 0.8 \text{ mA}^{(4)}$
V <sub>OL1</sub>	Output Low Voltage, port 0, ALE, PSEN <sup>(6)</sup>			0.3 0.45 1.0	V V V	$\begin{split} & \text{VCC} = 4.5 \text{V to } 5.5 \text{V} \\ & \text{I}_{\text{OL}} = 200 \; \mu \text{A}^{(4)} \\ & \text{I}_{\text{OL}} = 3.2 \; \text{m} \text{A}^{(4)} \\ & \text{I}_{\text{OL}} = 7.0 \; \text{m} \text{A}^{(4)} \end{split}$
				0.45	V	VCC = 2.7V to 5.5V $I_{OL}$ = 1.6 mA <sup>(4)</sup>
V <sub>OH</sub>	Output High Voltage, ports 1, 2, 3, 4	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$V_{CC} = 5V \pm 10\%$ $I_{OH} = -10 \ \mu A$ $I_{OH} = -30 \ \mu A$ $I_{OH} = -60 \ \mu A$
		0.9 V <sub>CC</sub>			V	VCC = 2.7V to 5.5V $I_{OH}$ = -10 $\mu$ A





### $T_A = -40^{\circ}C$ to $+85^{\circ}C$ ; $V_{SS} = 0V$ ;

 $V_{CC}$  =2.7V to 5.5V and F = 0 to 40 MHz (both internal and external code execution)

 $V_{CC}$  =4.5V to 5.5V and F = 0 to 60 MHz (internal code execution only) (Continued)

Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V <sub>OH1</sub>	Output High Voltage, port 0, ALE, PSEN	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$V_{CC} = 5V \pm 10\%$ $I_{OH} = -200 \mu A$ $I_{OH} = -3.2 m A$ $I_{OH} = -7.0 m A$
		0.9 V <sub>CC</sub>			V	VCC = 2.7V to 5.5V $I_{OH}$ = -10 $\mu$ A
R <sub>RST</sub>	RST Pulldown Resistor	50	200 <sup>(5)</sup>	250	kΩ	
I <sub>IL</sub>	Logical 0 Input Current ports 1, 2, 3, 4 and 5			-50	μΑ	V <sub>IN</sub> = 0.45V
ILI	Input Leakage Current for P0 only			±10	μΑ	$0.45V < V_{IN} < V_{CC}$
I <sub>TL</sub>	Logical 1 to 0 Transition Current, ports 1, 2, 3, 4			-650	μΑ	V <sub>IN</sub> = 2.0V
C <sub>IO</sub>	Capacitance of I/O Buffer			10	pF	Fc = 3 MHz TA = 25°C
I <sub>PD</sub>	Power Down Current		100	150	μΑ	$4.5V < V_{CC <} 5.5V^{(3)}$
I <sub>CCOP</sub>	Power Supply Current on normal mode			0.4 x Frequency (MHz) + 5	mA	$V_{CC} = 5.5 V^{(1)}$
	Power Supply Current on idle mode			0.3 x Frequency (MHz) + 5	mA	$V_{CC} = 5.5 V^{(1)}$
I <sub>CCProg</sub>	Power Supply Current during flash Write / Erase		0.4 x Frequency (MHz) + 20		mA	V <sub>CC</sub> = 5.5V <sup>(8)</sup>

Notes: 1. Operating I<sub>CC</sub> is measured with all output pins disconnected; XTAL1 driven with T<sub>CLCH</sub>, T<sub>CHCL</sub> = 5 ns (see Figure 49.), V<sub>IL</sub> = V<sub>SS</sub> + 0.5V,

 $V_{IH} = V_{CC} - 0.5V$ ; XTAL2 N.C.;  $\overline{EA} = RST = Port 0 = V_{CC}$ .  $I_{CC}$  would be slightly higher if a crystal oscillator used (see Figure 46).

- Idle I<sub>CC</sub> is measured with all output pins disconnected; XTAL1 driven with T<sub>CLCH</sub>, T<sub>CHCL</sub> = 5 ns, V<sub>IL</sub> = V<sub>SS</sub> + 0.5V, V<sub>IH</sub> = V<sub>CC</sub> 0.5V; XTAL2 N.C; Port 0 = V<sub>CC</sub>; EA = RST = V<sub>SS</sub> (see Figure 47).
- Power Down I<sub>CC</sub> is measured with all output pins disconnected; EA = V<sub>SS</sub>, PORT 0 = V<sub>CC</sub>; XTAL2 NC.; RST = V<sub>SS</sub> (see Figure 48).
- 4. Capacitance loading on Ports 0 and 2 may cause spurious noise pulses to be superimposed on the V<sub>OL</sub>s of ALE and Ports 1 and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins make 1 to 0 transitions during bus operation. In the worst cases (capacitive loading 100pF), the noise pulse on the ALE line may exceed 0.45V with maxi V<sub>OL</sub> peak 0.6V. A Schmitt Trigger use is not necessary.
- 5. Typical are based on a limited number of samples and are not guaranteed. The values listed are at room temperature and 5V.

 Under steady state (non-transient) conditions, I<sub>OL</sub> must be externally limited as follows: Maximum I<sub>OL</sub> per port pin: 10 mA Maximum I<sub>OL</sub> per 8-bit port: Port 0: 26 mA

Ports 1, 2 and 3: 15 mA

Maximum total IOL for all output pins: 71 mA

If I<sub>OL</sub> exceeds the test condition, V<sub>OL</sub> may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 7. For other values, please contact your sales office.
- 8. Icc Flash Write operation current while an on-chip flash page write is on going.
- 9. Flash Retention is guaranteed with the same formula for  $\rm V_{\rm CC}$  Min down to 0.

# DC Parameters for Low Voltage

TA = 0°C to +70°C; V<sub>SS</sub> = 0V; V<sub>CC</sub> = 2.7V to 3.6V; F = 0to 40 MHz TA = -40°C to +85°C; V<sub>SS</sub> = 0V; V<sub>CC</sub> = 2.7V to 3.6V; F = 0 to 40 MHz

Symbol	Parameter	Min	Тур	Мах	Unit	Test Conditions
V <sub>IL</sub>	Input Low Voltage	-0.5		0.2 V <sub>CC</sub> - 0.1	V	
V <sub>IH</sub>	Input High Voltage except RST, XTAL1	0.2 V <sub>CC</sub> + 0.9		V <sub>CC</sub> + 0.5	V	
V <sub>IH1</sub>	Input High Voltage, RST, XTAL1	0.7 V <sub>CC</sub>		V <sub>CC</sub> + 0.5	V	
V <sub>OL</sub>	Output Low Voltage, ports 1, 2, 3, 4 <sup>(6)</sup>			0.45	V	$I_{OL} = 0.8 \text{ mA}^{(4)}$
V <sub>OL1</sub>	Output Low Voltage, port 0, ALE, PSEN (6)			0.45	V	I <sub>OL</sub> = 1.6 mA <sup>(4)</sup>
V <sub>OH</sub>	Output High Voltage, ports 1, 2, 3, 4	0.9 V <sub>CC</sub>			V	I <sub>OH</sub> = -10 μA
V <sub>OH1</sub>	Output High Voltage, port 0, ALE, PSEN	0.9 V <sub>CC</sub>			V	I <sub>OH</sub> = -40 μA
I <sub>IL</sub>	Logical 0 Input Current ports 1, 2, 3, 4			-50	μA	V <sub>IN</sub> = 0.45 V
Ι <sub>U</sub>	Input Leakage Current for P0 only			±10	μA	$0.45 \mathrm{V} < \mathrm{V_{IN}} < \mathrm{V_{CC}}$
I <sub>TL</sub>	Logical 1 to 0 Transition Current, ports 1, 2, 3,			-650	μA	V <sub>IN</sub> = 2.0V
R <sub>RST</sub>	RST Pulldown Resistor	50	200 (5)	250	kΩ	
C <sub>IO</sub>	Capacitance of I/O Buffer			10	pF	Fc = 3 MHz TA = 25°C
I <sub>PD</sub>	Power Down Current		10 <sup>(5)</sup>	50	μA	$V_{CC} = 2.7V$ to 3.6V <sup>(3)</sup>
I <sub>CCOP</sub>	Power Supply Current on normal mode			0.4 x Frequency (MHz) + 5	mA	$V_{\rm CC} = 3.6 \ V^{(1)}$
	Power Supply Current on idle mode			0.3 x Frequency (MHz) + 5	mA	$V_{\rm CC} = 3.6 \ V^{(2)}$
I <sub>CCProg</sub>	Power Supply Current during flash Write / Erase		0.4 x Frequency (MHz) + 20		mA	V <sub>CC</sub> = 5.5V <sup>(8)</sup>

Notes: 1. Operating I<sub>CC</sub> is measured with all output pins disconnected; XTAL1 driven with T<sub>CLCH</sub>, T<sub>CHCL</sub> = 5 ns (see Figure 49.), V<sub>IL</sub> = V<sub>SS</sub> + 0.5V,

 $V_{IH} = V_{CC} - 0.5V$ ; XTAL2 N.C.;  $\overline{EA} = RST = Port 0 = V_{CC}$ .  $I_{CC}$  would be slightly higher if a crystal oscillator used (see Figure 46).

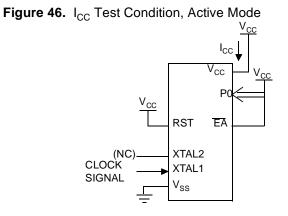
- Idle I<sub>CC</sub> is measured with all output pins disconnected; XTAL1 driven with T<sub>CLCH</sub>, T<sub>CHCL</sub> = 5 ns, V<sub>IL</sub> = V<sub>SS</sub> + 0.5V, V<sub>IH</sub> = V<sub>CC</sub> 0.5V; XTAL2 N.C; Port 0 = V<sub>CC</sub>; EA = RST = V<sub>SS</sub> (see Figure 47).
- Power Down I<sub>CC</sub> is measured with all output pins disconnected; EA = V<sub>SS</sub>, PORT 0 = V<sub>CC</sub>; XTAL2 NC.; RST = V<sub>SS</sub> (see Figure 48).
- 4. Capacitance loading on Ports 0 and 2 may cause spurious noise pulses to be superimposed on the V<sub>OL</sub>s of ALE and Ports 1 and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins make 1 to 0 transitions during bus operation. In the worst cases (capacitive loading 100pF), the noise pulse on the ALE line may exceed 0.45V with maxi V<sub>OL</sub> peak 0.6V. A Schmitt Trigger use is not necessary.
- 5. Typical are based on a limited number of samples and are not guaranteed. The values listed are at room temperature and 5V.
- Under steady state (non-transient) conditions, I<sub>OL</sub> must be externally limited as follows: Maximum I<sub>OL</sub> per port pin: 10 mA Maximum I<sub>OL</sub> per 8-bit port: Port 0: 26 mA Ports 1, 2 and 3: 15 mA Maximum total I<sub>OL</sub> for all output pins: 71 mA





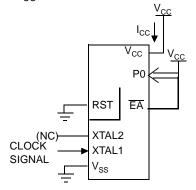
If  $I_{OL}$  exceeds the test condition,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 7. For other values, please contact your sales office.
- 8. Icc Flash Write operation current while an on-chip flash page write is on going.

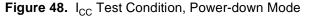


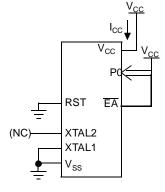
All other pins are disconnected.





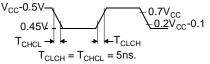
All other pins are disconnected.





All other pins are disconnected.

Figure 49. Clock Signal Waveform for  $I_{CC}$  Tests in Active and Idle Modes



### **AC Parameters**

Explanation of the AC Symbols	Each timing symbol has 5 characters. The first character is always a "T" (stands for time). The other characters, depending on their positions, stand for the name of a signal or the logical status of that signal. The following is a list of all the characters and what they stand for. Example: $T_{AVLL}$ = Time for Address Valid to ALE Low. $T_{LLPL}$ = Time for ALE Low to PSEN Low.
	(Load Capacitance for port 0, ALE and PSEN = 100 pF; Load Capacitance for all other outputs = 80 pF.)
	Table 75 Table 78, and Table 80 give the description of each AC symbols.
	Table 77, Table 79 and Table 81 give the AC parameterfor each range.
	Table 76, Table 77 and Table 82 gives the frequency derating formula of the AC param- eter for each speed range description. To calculate each AC symbols, take the x value in the correponding column (-M or -L) and use this value in the formula.
	Example: T <sub>LLIU</sub> for -M and 20 MHz, Standard clock. x = 35 ns T 50 ns T <sub>CCIV</sub> = 4T - x = 165 ns
External Program Memory	Table 75. Symbol Description

#### Characteristics

Symbol	Parameter
Т	Oscillator clock period
T <sub>LHLL</sub>	ALE pulse width
T <sub>AVLL</sub>	Address Valid to ALE
T <sub>LLAX</sub>	Address Hold after ALE
T <sub>LLIV</sub>	ALE to Valid Instruction In
T <sub>LLPL</sub>	ALE to PSEN
T <sub>PLPH</sub>	PSEN Pulse Width
T <sub>PLIV</sub>	PSEN to Valid Instruction In
T <sub>PXIX</sub>	Input Instruction Hold after PSEN
T <sub>PXIZ</sub>	Input Instruction Float after PSEN
T <sub>AVIV</sub>	Address to Valid Instruction In
T <sub>PLAZ</sub>	PSEN Low to Address Float





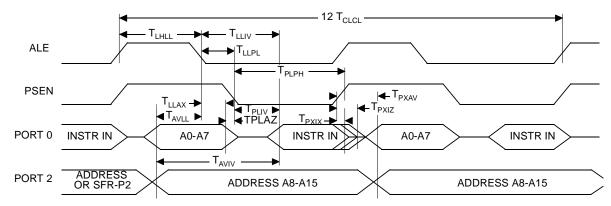
Table 76. AC Parameters for a Fix Clock

Symbol	-М			-L	Units
	Min	Max	Min	Мах	
т	25		25		ns
T <sub>LHLL</sub>	35		35		ns
T <sub>AVLL</sub>	5		5		ns
T <sub>LLAX</sub>	5		5		ns
T <sub>LLIV</sub>		n 65		65	ns
T <sub>LLPL</sub>	5		5		ns
T <sub>PLPH</sub>	50		50		ns
T <sub>PLIV</sub>		30		30	ns
T <sub>PXIX</sub>	0		0		ns
T <sub>PXIZ</sub>		10		10	ns
T <sub>AVIV</sub>		80		80	ns
T <sub>PLAZ</sub>		10		10	ns

 Table 77. AC Parameters for a Variable Clock

Symbol	Туре	Standard Clock	X2 Clock	X Parameter for - M Range	X Parameter for -L Range	Units
T <sub>LHLL</sub>	Min	2 T - x	T - x	15	15	ns
T <sub>AVLL</sub>	Min	Т - х	0.5 T - x	20	20	ns
T <sub>LLAX</sub>	Min	T - x	0.5 T - x	20	20	ns
T <sub>LLIV</sub>	Max	4 T - x	2 T - x	35	35	ns
T <sub>LLPL</sub>	Min	T - x	0.5 T - x	15	15	ns
T <sub>PLPH</sub>	Min	3 T - x	1.5 T - x	25	25	ns
T <sub>PLIV</sub>	Max	3 T - x	1.5 T - x	45	45	ns
T <sub>PXIX</sub>	Min	х	х	0	0	ns
T <sub>PXIZ</sub>	Max	T - x	0.5 T - x	15	15	ns
T <sub>AVIV</sub>	Max	5 T - x	2.5 T - x	45	45	ns
T <sub>PLAZ</sub>	Max	х	х	10	10	ns

### External Program Memory Read Cycle



#### External Data Memory Characteristics

Table 78. Symbol Description

Symbol	Parameter
T <sub>RLRH</sub>	RD Pulse Width
T <sub>WLWH</sub>	WR Pulse Width
T <sub>RLDV</sub>	RD to Valid Data In
T <sub>RHDX</sub>	Data Hold After RD
T <sub>RHDZ</sub>	Data Float After RD
T <sub>LLDV</sub>	ALE to Valid Data In
T <sub>AVDV</sub>	Address to Valid Data In
T <sub>LLWL</sub>	ALE to WR or RD
T <sub>AVWL</sub>	Address to WR or RD
T <sub>QVWX</sub>	Data Valid to WR Transition
T <sub>QVWH</sub>	Data set-up to WR High
T <sub>WHQX</sub>	Data Hold After WR
T <sub>RLAZ</sub>	RD Low to Address Float
T <sub>WHLH</sub>	RD or WR High to ALE high

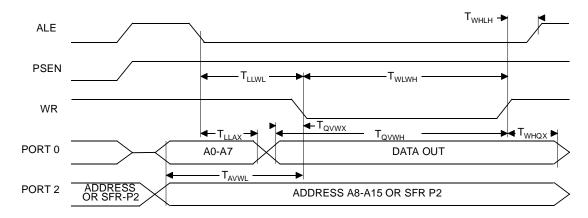




	-М			-L		
Symbol	Min	Max	Min	Мах	Units	
T <sub>RLRH</sub>	125		125		ns	
T <sub>WLWH</sub>	125		125		ns	
T <sub>RLDV</sub>		95		95	ns	
T <sub>RHDX</sub>	0		0		ns	
T <sub>RHDZ</sub>		25		25	ns	
T <sub>LLDV</sub>		155		155	ns	
T <sub>AVDV</sub>		160		160	ns	
T <sub>LLWL</sub>	45	105	45	105	ns	
T <sub>AVWL</sub>	70		70		ns	
T <sub>QVWX</sub>	5		5		ns	
T <sub>QVWH</sub>	155		155		ns	
T <sub>WHQX</sub>	10		10		ns	
T <sub>RLAZ</sub>	0		0		ns	
T <sub>WHLH</sub>	5	45	5	45	ns	

Symbol	Туре	Standard Clock	X2 Clock	X Parameter for - M Range	X Parameter for - L Range	Units
T <sub>RLRH</sub>	Min	6 T - x	3 T - x	25	25	ns
T <sub>WLWH</sub>	Min	6 T - x	3 T - x	25	25	ns
T <sub>RLDV</sub>	Max	5 T - x	2.5 T - x	30	30	ns
T <sub>RHDX</sub>	Min	x	х	0	0	ns
T <sub>RHDZ</sub>	Max	2 T - x	T - x	25	25	ns
T <sub>LLDV</sub>	Max	8 T - x	4T -x	45	45	ns
T <sub>AVDV</sub>	Max	9 T - x	4.5 T - x	65	65	ns
T <sub>LLWL</sub>	Min	3 T - x	1.5 T - x	30	30	ns
T <sub>LLWL</sub>	Max	3 T + x	1.5 T + x	30	30	ns
T <sub>AVWL</sub>	Min	4 T - x	2 T - x	30	30	ns
T <sub>QVWX</sub>	Min	T - x	0.5 T - x	20	20	ns
T <sub>QVWH</sub>	Min	7 T - x	3.5 T - x	20	20	ns
T <sub>WHQX</sub>	Min	T - x	0.5 T - x	15	15	ns
T <sub>RLAZ</sub>	Max	x	х	0	0	ns
T <sub>WHLH</sub>	Min	T - x	0.5 T - x	20	20	ns
T <sub>WHLH</sub>	Max	T + x	0.5 T + x	20	20	ns

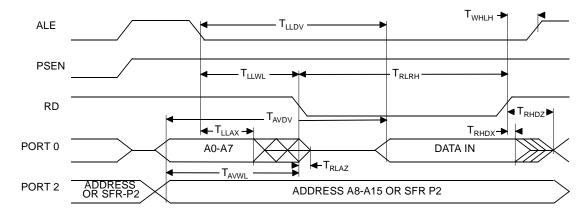
## External Data Memory Write Cycle







#### **External Data Memory Read Cycle**



### Serial Port Timing - Shift Register Mode

Table 80. Symbol Description

Symbol	Parameter			
T <sub>XLXL</sub>	T <sub>XLXL</sub> Serial port clock cycle time			
T <sub>QVHX</sub>	Output data set-up to clock rising edge			
T <sub>XHQX</sub>	Output data hold after clock rising edge			
T <sub>XHDX</sub>	Input data hold after clock rising edge			
T <sub>XHDV</sub>	Clock rising edge to input data valid			

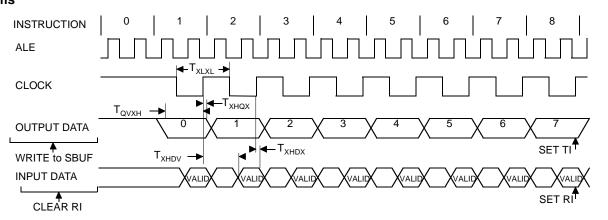
#### Table 81. AC Parameters for a Fix Clock

	-М			-L	
Symbol	Min	Max	Min	Мах	Units
T <sub>XLXL</sub>	300		300		ns
T <sub>QVHX</sub>	200		200		ns
T <sub>XHQX</sub>	30		30		ns
T <sub>XHDX</sub>	0		0		ns
T <sub>XHDV</sub>		117		117	ns

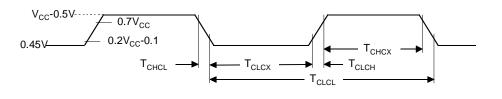
Table 82. A	AC Parameters	for a ∖	ariable Clock
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Symbol	Туре	Standard Clock	X2 Clock	X Parameter for - M Range	X Parameter for -L Range	Units
T <sub>XLXL</sub>	Min	12 T	6 T			ns
T <sub>QVHX</sub>	Min	10 T - x	5 T - x	50	50	ns
T <sub>XHQX</sub>	Min	2 T - x	Т - х	20	20	ns
T <sub>XHDX</sub>	Min	x	х	0	0	ns
T <sub>XHDV</sub>	Max	10 T - x	5 T- x	133	133	ns

### Shift Register Timing Waveforms

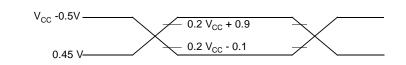


### External Clock Drive Waveforms



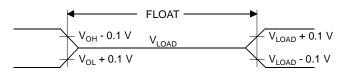
#### AC Testing Input/Output Waveforms

INPUT/OUTPUT



AC inputs during testing are driven at V<sub>CC</sub> - 0.5 for a logic "1" and 0.45V for a logic "0". Timing measurement are made at V<sub>IH</sub> min for a logic "1" and V<sub>IL</sub> max for a logic "0".

### **Float Waveforms**



For timing purposes as port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loaded  $V_{OH}/V_{OL}$  level occurs.  $I_{OL}/I_{OH} \ge \pm 20$ mA.

### **Clock Waveforms**

Valid in normal clock mode. In X2 mode XTAL2 must be changed to XTAL2/2.



Figure 50. Internal Clock Signals STATE4 STATE5 STATE6 STATE2 STATE3 STATE4 STATE5 STATE1 INTERNAL CLOCK P1 P2 P1 P2 P2 P1 P2 P1 P2 P1 P2 P1 P2 P1 P2 XTAL2 ALE THESE SIGNALS ARE NOT ACTIVATED DURING THE EXECUTION OF A MOVX INSTRUCTION **EXTERNAL PROGRAM MEMORY FETCH** PSEN P0 PCL OUT DATA DATA PCL OUT DATA PCL OUT SAMPLEE SAMPLEE SAMPLED FLOAT **FLOAT** FLOAT. P2 (EXT) INDICATES ADDRESS TRANSITIONS **READ CYCLE** RD PCL OUT (IF PROGRAM MEMORY IS EXTERNAL) P0 DPL OR Rt OU DATA SAMPLED FLOAT INDICATES DPH OR P2 SFR TO PCH TRANSITION P2 WRITE CYCLE PCL OUT (EVEN IF PROGRAM MEMORY IS INTERNAL) WR P0 DPL OR Rt OUT PCL OUT (IF PROGRAM MEMORY IS EXTERNAL) DATA OUT INDICATES DPH OR P2 SFR TO PCH TRANSITION P2 PORT OPERATION MOV PORT SRC OLD DATA NEW DATA P0 PINS SAMPLED P0 PINS SAMPLED MOV DEST P0 Ι. MOV DEST PORT (P1. P2. P3) (INCLUDES INTO. INT1. TO T1) P1, P2, P3 PINS SAMPLED P1, P2, P3 PINS SAMPLED SERIAL PORT SHIFT CLOCK RXD SAMPLED RXD SAMPLED TXD (MODE 0)

This diagram indicates when signals are clocked internally. The time it takes the signals to propagate to the pins, however, ranges from 25 to 125 ns. This propagation delay is dependent on variables such as temperature and pin loading. Propagation also varies from output to output and component. Typically though ( $T_A = 25^{\circ}C$  fully loaded)  $\overline{RD}$  and  $\overline{WR}$  propagation delays are approximately 50 ns. The other signals are typically 85 ns. Propagation delays are incorporated in the AC specifications.

### **Ordering Information**

 Table 83.
 Possible Order Entries

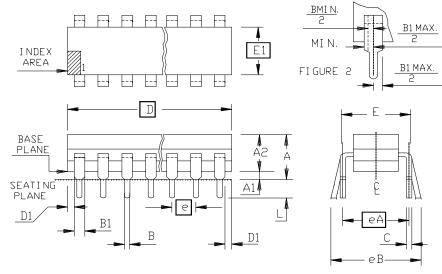
Part Number	Memory Size	Supply Voltage	Temperature Range	Package	Packing	Product Marking
AT89C51RB2-3CSIM	16 KBytes	5V	Industrial	PDIL40	Stick	89C51RB2-IM
AT89C51RB2-SLSCM		5V	Commercial	PLCC44	Stick	89C51RB2-CM
AT89C51RB2-SLSIM		5V	Industrial	PLCC44	Stick	89C51RB2-IM
AT89C51RB2-RLTCM		5V	Commercial	VQFP44	Tray	89C51RB2-CM
AT89C51RB2-RLTIM		5V	Industrial	VQFP44	Tray	89C51RB2-IM
AT89C51RB2-SLSIL		3V	Industrial	PLCC44	Stick	89C51RB2-IL
AT89C51RB2-RLTIL	1	3V	Industrial	VQFP44	Tray	89C51RB2-IL
AT89C51RC2-3CSCM		5V	Commercial	PDIL40	Stick	89C51RC2-CM
AT89C51RC2-3CSIM		5V	Industrial	PDIL40	Stick	89C51RC2-IM
AT89C51RC2-SLSCM		5V	Commercial	PLCC44	Stick	89C51RC2-CM
AT89C51RC2-SLSIM		5V	Industrial	PLCC44	Stick	89C51RC2-IM
AT89C51RC2-RLTCM	- 32 KBytes	5V	Commercial	VQFP44	Tray	89C51RC2-CM
AT89C51RC2-RLTIM		5V	Industrial	VQFP44	Tray	89C51RC2-IM
AT89C51RC2-SLSIL		3V	Industrial	PLCC44	Stick	89C51RC2-IL
AT89C51RC2-RLTIL		3V	Industrial	VQFP44	Tray	89C51RC2-IL
AT89C51RB2-3CSUM		5V	Industrial & Green	PDIL40	Stick	89C51RB2-UN
AT89C51RB2-SLSUM		5V	Industrial & Green	PLCC44	Stick	89C51RB2-UM
AT89C51RB2-RLTUM	AC KDutes	5V	Industrial & Green	VQFP44	Tray	89C51RB2-UM
AT89C51RB2-SLSUL	16 KBytes	3V	Industrial & Green	PLCC44	Stick	89C51RB2-UL
AT89C51RB2-RLTUL		3V	Industrial & Green	VQFP44	Tray	89C51RB2-UL
AT89C51RB2-RLTUM	]	5V	Industrial & Green	VQFP44	Tray	89C51RB2-UM
AT89C51RC2-3CSUM		5V	Industrial & Green	PDIL40	Stick	89C51RC2-UN
AT89C51RC2-SLSUM	32 KBytes	5V	Industrial & Green	PLCC44	Stick	89C51RC2-UN
AT89C51RC2-RLTUM		5V	Industrial & Green	VQFP44	Tray	89C51RC2-UN
AT89C51RC2-SLSUL		3V	Industrial & Green	PLCC44	Stick	89C51RC2-UL
AT89C51RC2-RLTUL		3V	Industrial & Green	VQFP44	Tray	89C51RC2-UL





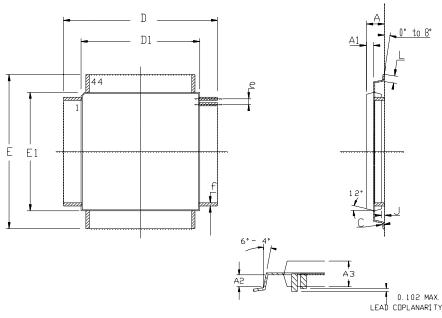
### **Package Information**

### PDIL40



		ММ	INCH		
A	-	5.08	-	. 200	
A1	0.38	-	. 015	-	
A2	3.18	4. 95	. 125	. 195	
В	0.36	0.56	. 014	. 022	
B1	0.76	1.78	. 030	. 070	
С	0.20	0.38	. 008	. 015	
D	50.29	53. 21	1.980	2.095	
E	15.24	15.87	. 600	. 625	
E1	12.32	14.73	. 485	. 580	
e	2. 54	B. S. C	. 100	B. S. C	
eA	15.24	B. S. C	. 600	B. S. C	
еB	-	17.78	-	. 700	
L	2. 93	3. 81	. 115	. 150	
D1	0.13	-	. 005	-	
P	KG STD	02		-	

### VQFP44

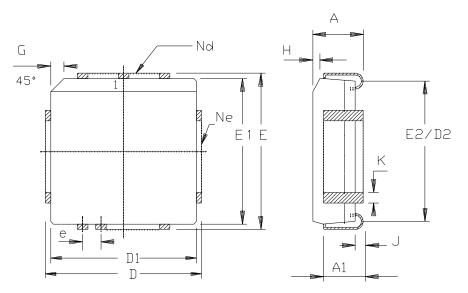


	М	М	INCH		
	Min	Max	Min	Max	
А	-	1.60	_	. 063	
A1	Ο.	64 REF	.025 REF		
A2	Ο.	64 REF	.025 REF		
A3	1.35	1.45	. 053	. 057	
D	11.90	12.10	. 468	. 476	
D1	9, 90	10.10	. 390	. 398	
E	11.90	12.10	. 468	. 476	
E1	9, 90	10.10	. 390	. 398	
J	0.05	-	. 002	-	
L 0.45		0.75	. 018	. 030	
e	0.8	0 BSC	. 03	15 BSC	
f	0.3	5 BSC	. 01	4 BSC	





### PLC44



	1	۹M ·	IN	СН
A	4, 20	4. 57	. 165	. 180
A1	2. 29	3.04	. 090	. 1 20
D	17.40	17.65	. 685	. 695
D1	16.44	16.66	. 647	. 656
DS	14.99	16.00	. 590	. 630
E	17.40	17.65	. 685	. 695
E1	16.44	16.66	. 647	. 656
E5	14.99	16.00	. 590	. 630
e	1.27	BSC	. 050	BSC
G	1.07	1.22	. 042	. 048
н	1.07	1.42	. 042	. 056
J	0.51	-	. 020	-
К	0.33	0.53	. 013	. 021
Nd	1	. 1	1	1
Ne	1	. 1	1	1
P	KG STD	00		

### Datasheet Change Log

Changes from 4180A- 08/02 to 4180B-04/03		Changed the endurance of Flash to 100, 000 Write/Erase cycles. Added note on Flash retention formula for $V_{IH1}$ , in Section "DC Parameters for Standard Voltage", page 107.
Changes from 4180B- 04/03 to 4180C-12/03	1.	Max frequency update for 4.5 to 5.5V range up to 60 MHz (internal code execution).
Changes from 4180C- 12/03 - 4180D - 06/05	1.	Added Green product ordering information. Page 119.
Changes from 4180D - 06/05 to 4180E - 10/06	1.	Correction to PDIL40 figure on page 9.



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